

## 19-Output PCIe 4.0/5.0 Clock Generator With On-chip Termination

### Features

- Supports Intel's CK440Q spec
- 3.3V supply voltage
- 25MHz crystal or an input from a XO / TCXO / OCXO for meeting customer specific PPM requirements
- 19 differential clock output pairs @ 1.4V differential into PCI Express\* (PCIe\*) compliant test load
  - 7 dedicated 100MHz outputs
  - 3 dedicated 25MHz outputs
  - 9 selectable outputs capable of driving 25M or 100MHz
- 85Ω Differential drivers
- Programmable SSC on the 100 MHz
- SMBus Programmable Configurations with multiple SMBus addresses
- Two Tri-level Addresses Selection (9 SMBus Addresses)
- PCIe compatible OE# control on 7 pins, and 3 wire shift / load control on all outputs
- Very low jitter outputs: 0.08 ps effective phase jitter after PCIe 5.0 transfer function
- Dedicated pins for Platform Time Input & Output (PFT\_IN & PFT\_OUT) clocking
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative.  
<https://www.diodes.com/quality/product-definitions/>
- Packaging (Pb-free & Green):
  - 100-Contact, 8 x 8 mm UQFN (ZUD)

### Description

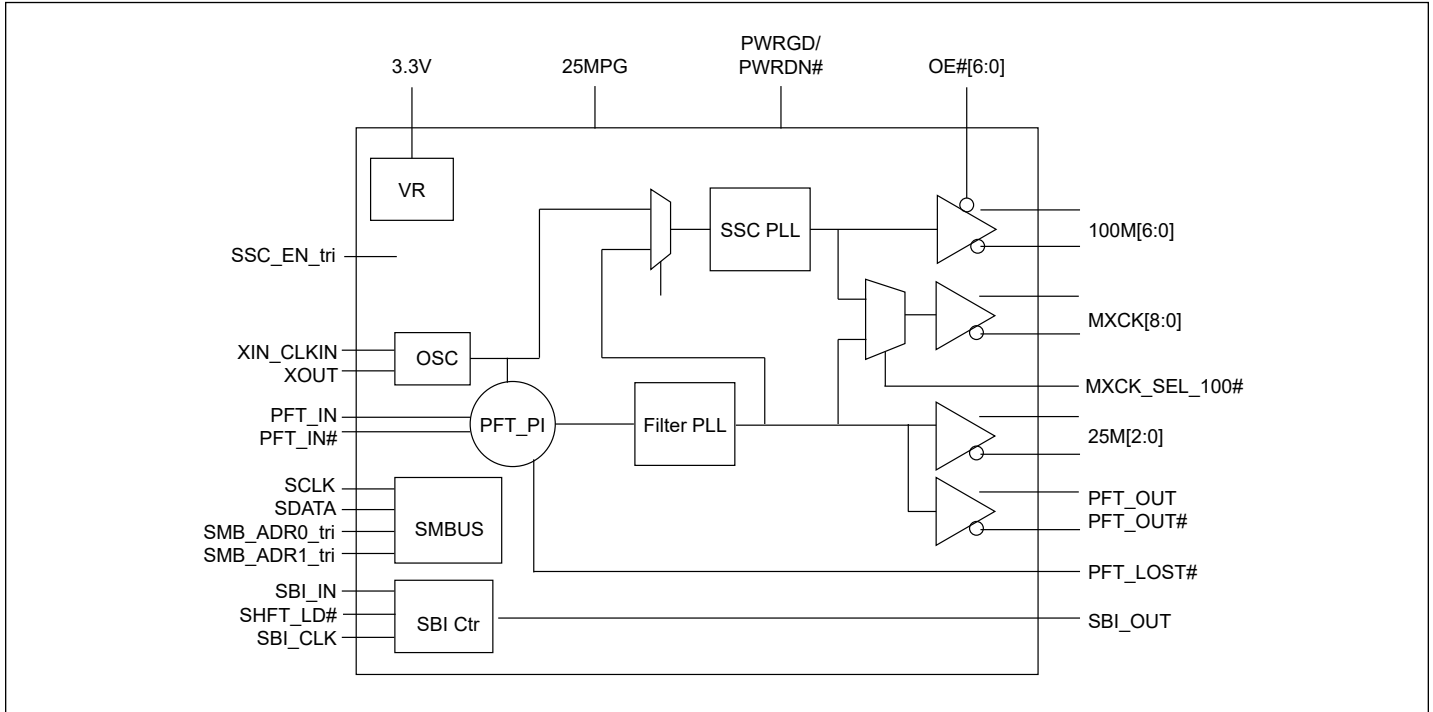
The PI6CG330440 is a 19-output very low jitter clock generator. It takes an reference input to generate 25MHz and 100MHz outputs. The on-chip termination can save 80 external resistors and make layout easier. Individual OE pin for each output provides easier power management.

It uses Diodes' proprietary design to achieve very low jitter that meets PCIe 1.0/2.0/3.0/4.0/5.0 clock requirements.

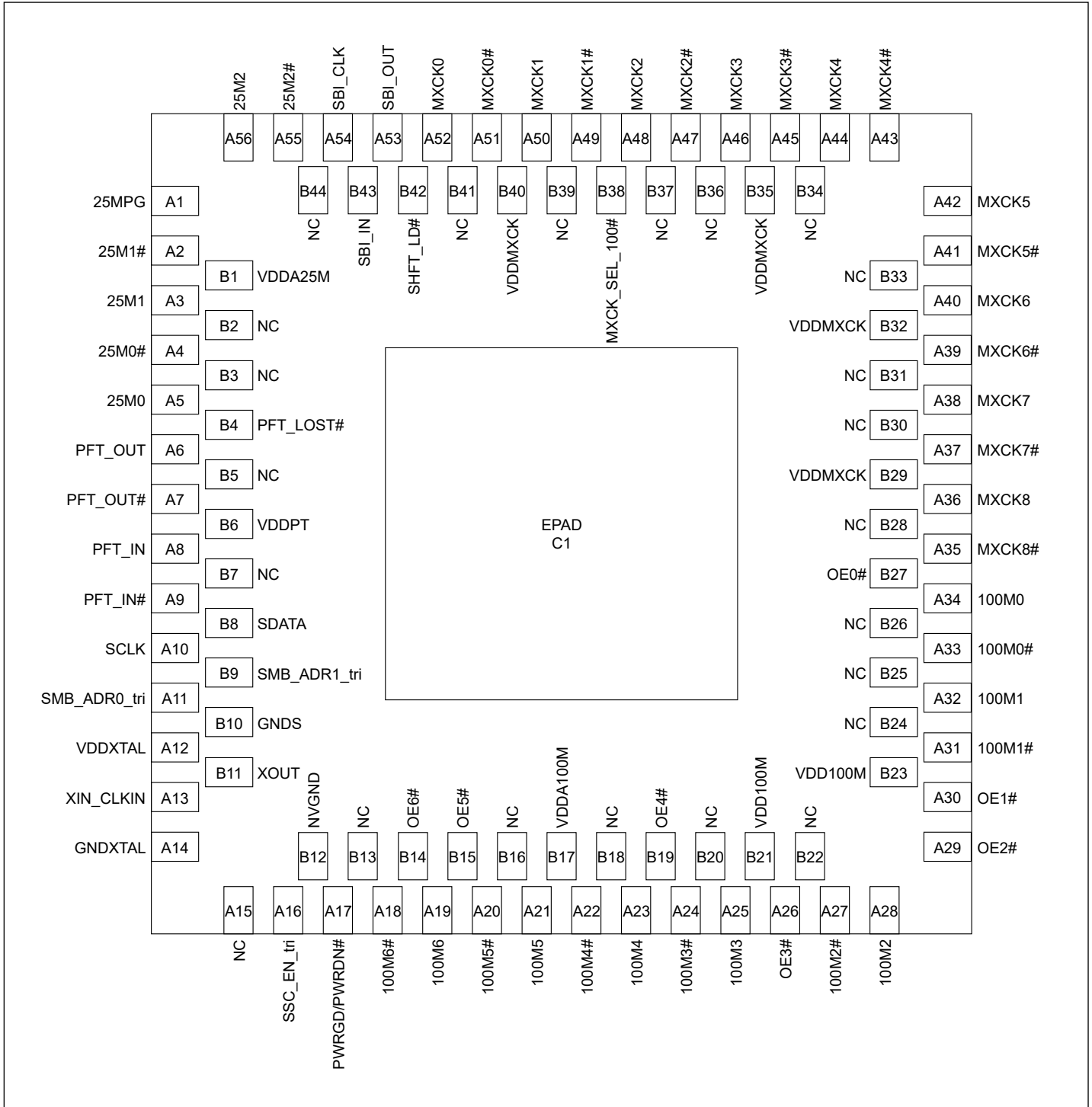
#### Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Block Diagram



## Pin Configuration



## Pin Description

| Pin Number | Pin Name         | Type          |       | Description                                                                                                                                                                                 |
|------------|------------------|---------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1         | 25MPG            | Input,<br>PDT | LVTTL | Input to assert power good for the 25M2 output pair before PWRGD is asserted. It has internal pull down resistor.                                                                           |
| A2         | 25M1#            | Output        | HCSL  | ±0.7V differential 25MHz clock complement output.                                                                                                                                           |
| A3         | 25M1             | Output        | HCSL  | ±0.7V differential 25MHz clock true output.                                                                                                                                                 |
| A4         | 25M0#            | Output        | HCSL  | ±0.7V differential 25MHz clock complement output.                                                                                                                                           |
| A5         | 25M0             | Output        | HCSL  | ±0.7V differential 25MHz clock true output.                                                                                                                                                 |
| A6         | PFT_OUT          | Output        | HCSL  | ±0.7V 25MHz differential platform time output.                                                                                                                                              |
| A7         | PFT_OUT#         | Output        | HCSL  | ±0.7V 25MHz differential platform time complement output.                                                                                                                                   |
| A8         | PFT_IN           | Input,<br>PDT | HCSL  | ±0.7V 25MHz differential platform time input.                                                                                                                                               |
| A9         | PFT_IN#          | Input,<br>PDT | HCSL  | ±0.7V 25MHz differential platform time input.                                                                                                                                               |
| A10        | SCLK             | Input,<br>PDT | LVTTL | SMBus slave clock input.                                                                                                                                                                    |
| A11        | SMB_ADR0_tri     | Input         | LVTTL | Tri-level LVTTL input to select SMBus address. This pin has internal pull up and pull down resistors. Refer to tri-level input threshold table.                                             |
| A12        | VDDXTAL          | Power         |       | Power supply for crystal and clock input.                                                                                                                                                   |
| A13        | XIN_CLKIN        | Input,<br>PDT |       | Crystal input/Single-ended input.                                                                                                                                                           |
| A14        | GNDXTAL          | GND           |       | Ground for crystal                                                                                                                                                                          |
| A15        | NC               | —             |       | No connect                                                                                                                                                                                  |
| A16        | SSC_EN_tri       | Input         | LVTTL | Tri-level input to enable or disable spread spectrum. Refer to tri-level input threshold table.<br>0 = SSC off, MID = -0.3% max, and HIGH = -0.5% max. It has internal pull down resistor." |
| A17        | PWRGD/<br>PWRDN# | Input         | LVTTL | Input to power up or power down the device. It has internal pull up resistor.                                                                                                               |
| A18        | 100M6#           | Output        | HCSL  | ±0.7V differential 100MHz clock complement output.                                                                                                                                          |
| A19        | 100M6            | Output        | HCSL  | ±0.7V differential 100MHz clock true output.                                                                                                                                                |
| A20        | 100M5#           | Output        | HCSL  | ±0.7V differential 100MHz clock complement output.                                                                                                                                          |
| A21        | 100M5            | Output        | HCSL  | ±0.7V differential 100MHz clock true output.                                                                                                                                                |
| A22        | 100M4#           | Output        | HCSL  | ±0.7V differential 100MHz clock complement output.                                                                                                                                          |
| A23        | 100M4            | Output        | HCSL  | ±0.7V differential 100MHz clock true output.                                                                                                                                                |
| A24        | 100M3#           | Output        | HCSL  | ±0.7V differential 100MHz clock complement output.                                                                                                                                          |
| A25        | 100M3            | Output        | HCSL  | ±0.7V differential 100MHz clock true output.                                                                                                                                                |
| A26        | OE3#             | Input,<br>PDT | LVTTL | Active low input for enabling 100M3. 1 = disable output, 0 = enable output. It has internal pull down resistor.                                                                             |
| A27        | 100M2#           | Output        | HCSL  | ±0.7V differential 100MHz clock complement output.                                                                                                                                          |
| A28        | 100M2            | Output        | HCSL  | ±0.7V differential 100MHz clock true output.                                                                                                                                                |

## Pin Description Cont.

| Pin Number | Pin Name  | Type          |               | Description                                                                                                     |
|------------|-----------|---------------|---------------|-----------------------------------------------------------------------------------------------------------------|
| A29        | OE2#      | Input,<br>PDT | LVTTL         | Active low input for enabling 100M2. 1 = disable output, 0 = enable output. It has internal pull down resistor. |
| A30        | OE1#      | Input,<br>PDT | LVTTL         | Active low input for enabling 100M1. 1 = disable output, 0 = enable output. It has internal pull down resistor. |
| A31        | 100M1#    | Output        | HCSL          | ±0.7V differential 100MHz clock complement output.                                                              |
| A32        | 100M1     | Output        | HCSL          | ±0.7V differential 100MHz clock true output.                                                                    |
| A33        | 100M0#    | Output        | HCSL          | ±0.7V differential 100MHz clock complement output.                                                              |
| A34        | 100M0     | Output        | HCSL          | ±0.7V differential 100MHz clock true output.                                                                    |
| A35        | MXCK8#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A36        | MXCK8     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A37        | MXCK7#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A38        | MXCK7     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A39        | MXCK6#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A40        | MXCK6     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A41        | MXCK5#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A42        | MXCK5     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A43        | MXCK4#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A44        | MXCK4     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A45        | MXCK3#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A46        | MXCK3     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A47        | MXCK2#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A48        | MXCK2     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A49        | MXCK1#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A50        | MXCK1     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A51        | MXCK0#    | Output        | HCSL          | ±0.7V differential multiplexable clock complement output.                                                       |
| A52        | MXCK0     | Output        | HCSL          | ±0.7V differential multiplexable clock true output.                                                             |
| A53        | SBI_OUT   | Output        | LVTTL         | Side Band Interface data output.                                                                                |
| A54        | SBI_CLK   | Input,<br>PDT | LVTTL         | Side Band Interface clock input for shifting/loading the SBI interface. It has internal pull down resistor.     |
| A55        | 25M2#     | Output        | HCSL          | ±0.7V differential 25MHz clock complement output.                                                               |
| A56        | 25M2      | Output        | HCSL          | ±0.7V differential 25MHz clock true output.                                                                     |
| B1         | VDDA25M   | Power         |               | Analog power supply for 25M outputs.                                                                            |
| B2         | NC        | —             |               | No connect                                                                                                      |
| B3         | NC        | —             |               | No connect                                                                                                      |
| B4         | PFT_LOST# | Output        | Open<br>Drain | Asserts when PFT_IN, PFT_IN# clock is not present.                                                              |
| B5         | NC        | —             |               | No connect                                                                                                      |
| B6         | VDDPT     | Power         |               | Power supply for platform time circuit and digital.                                                             |

## Pin Description Cont.

| Pin Number | Pin Name     | Type             |               | Description                                                                                                                                     |
|------------|--------------|------------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| B7         | NC           | —                |               | No connect                                                                                                                                      |
| B8         | SDATA        | Input/<br>Output | Open<br>Drain | Open drain bi-directional SMBus data pin.                                                                                                       |
| B9         | SMB_ADR1_tri | Input            | LVTTL         | Tri-level LVTTL input to select SMBus address. This pin has internal pull up and pull down resistors. Refer to tri-level input threshold table. |
| B10        | GNDS         | GND              |               | Package shield ground for crystal oscillator circuit. This pin is not connected internally.                                                     |
| B11        | XOUT         | Output           |               | Output of internal crystal oscillator. This pin should be left floating if CLK_IN function is being used.                                       |
| B12        | NVGND        | GND              |               | Ground                                                                                                                                          |
| B13        | NC           | —                |               | No connect                                                                                                                                      |
| B14        | OE6#         | Input,<br>PDT    | LVTTL         | Active low input for enabling 100M6. 1 = disable output, 0 = enable output. It has internal pull down resistor.                                 |
| B15        | OE5#         | Input,<br>PDT    | LVTTL         | Active low input for enabling 100M5. 1 = disable output, 0 = enable output. It has internal pull down resistor.                                 |
| B16        | NC           | —                |               | No connect                                                                                                                                      |
| B17        | VDDA100M     | Power            |               | Analog power supply for 100M outputs.                                                                                                           |
| B18        | NC           | —                |               | No connect                                                                                                                                      |
| B19        | OE4#         | Input,<br>PDT    | LVTTL         | Active low input for enabling 100M4. 1 = disable output, 0 = enable output. It has internal pull down resistor.                                 |
| B20        | NC           | —                |               | No connect                                                                                                                                      |
| B21        | VDD100M      | Power            |               | Power supply for 100M outputs.                                                                                                                  |
| B22        | NC           | —                |               | No connect                                                                                                                                      |
| B23        | VDD100M      | Power            |               | Power supply for 100M outputs.                                                                                                                  |
| B24        | NC           | —                |               | No connect                                                                                                                                      |
| B25        | NC           | —                |               | No connect                                                                                                                                      |
| B26        | NC           | —                |               | No connect                                                                                                                                      |
| B27        | OE0#         | Input,<br>PDT    | LVTTL         | Active low input for enabling 100M0. 1 = disable output, 0 = enable output. It has internal pull down resistor.                                 |
| B28        | NC           | —                |               | No connect                                                                                                                                      |
| B29        | VDDMXCK      | Power            |               | Power supply for MXCK outputs.                                                                                                                  |
| B30        | NC           | —                |               | No connect                                                                                                                                      |
| B31        | NC           | —                |               | No connect                                                                                                                                      |
| B32        | VDDMXCK      | Power            |               | Power supply for MXCK outputs.                                                                                                                  |
| B33        | NC           | —                |               | No connect                                                                                                                                      |
| B34        | NC           | —                |               | No connect                                                                                                                                      |
| B35        | VDDMXCK      | Power            |               | Power supply for MXCK outputs.                                                                                                                  |
| B36        | NC           | —                |               | No connect                                                                                                                                      |
| B37        | NC           | —                |               | No connect                                                                                                                                      |

## Pin Description Cont.

| Pin Number | Pin Name       | Type          |       | Description                                                                                                                                      |
|------------|----------------|---------------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| B38        | MXCK_SEL_100M# | Input         | LVTTL | Input to select the source of the multiplexable clock outputs. 0 = 100 MHz, 1 = 25 MHz. It has internal pull down resistor.                      |
| B39        | NC             | —             |       | No connect                                                                                                                                       |
| B40        | VDDMXCK        | Power         |       | Power supply for MXCK outputs.                                                                                                                   |
| B41        | NC             | —             |       | No connect                                                                                                                                       |
| B42        | SHFT_LD#       | Input,<br>PDT | LVTTL | Input to control shifting and loading of the Side-Band Interface to the Output Enable Control Register. The pin has internal pull down resistor. |
| B43        | SBI_IN         | Input,<br>PDT | LVTTL | Side Band Interface data input. It has internal pull down resistor.                                                                              |
| B44        | NC             | —             |       | No connect                                                                                                                                       |
| C1         | EPAD           | GND           |       | Connect EPAD to ground.                                                                                                                          |

## Power Down Tolerant (PDT)

The pins with PDT type may be driven by external signals when the device is in a power down or reset condition. The device must reset and power up properly if these pins are driven to any valid voltage prior to the assertion of VDD or PWRGD#.

### Power Management Table for 100M[6:0] Outputs

| PWRGD/PWRDN# | OEx# Pin | SMBus OE Bit | SBI Mask Bit | SBI Output Control Register | 100M[6:0] |
|--------------|----------|--------------|--------------|-----------------------------|-----------|
| 0            | X        | X            | X            | X                           | Disabled  |
| 1            | 1        | X            | X            | X                           | Disabled  |
|              | X        | 0            | X            | X                           | Disabled  |
|              | X        | X            | 0            | 0                           | Disabled  |
|              | 0        | 1            | X            | 1                           | Running   |
|              | 0        | 1            | 1            | X                           | Running   |

### Power Management Table for 25M[2:0] and MXCK[8:0] Outputs

| PWRGD/PWRDN# | SMBus OE Bit | SBI Mask Bit | SBI Output Control Register | 25MPG | 25M[1:0], MXCK[8:0] | 25M[2]   |
|--------------|--------------|--------------|-----------------------------|-------|---------------------|----------|
| 0            | X            | X            | X                           | 0     | Disabled            | Disabled |
|              | X            | X            | X                           | 1     | Disabled            | Running  |
| 1            | 0            | X            | X                           | X     | Disabled            | Disabled |
|              | 1            | 0            | 0                           | X     | Disabled            | Disabled |
|              | 1            | X            | 1                           | X     | Running             | Running  |
|              | 1            | 1            | X                           | X     | Running             | Running  |

## Power Good and Power Down

PWRGD is asserted high and de-asserted low. De-assertion of PWRGD (pulling the signal low) is equivalent to indicating a power down condition. PWRGD (assertion) is used by the PI6CG330440 to sample initial configurations such as SMB\_ADRn\_tri selections.

After PWRGD has been asserted high for the first time, the pin becomes a PWRDN# (Power Down) pin that can be used to shut off all clocks cleanly and instruct the device to invoke power savings mode. PWRDN# is a completely asynchronous active low input. When entering power savings mode, PWRDN# should be asserted low prior to shutting off the input clock or power to ensure all clocks shut down in a glitch free manner. When PWRDN# is de-asserted high, all clocks will start and stop without any abnormal behavior and will meet all AC and DC parameters. The assertion and de-assertion of PWRDN# is asynchronous.

When PWRDN# is sampled low by two consecutive rising edges of 100M#, all differential outputs must held low on the next 100M# high to low transition, as shown in Figure 1.

PWRGD to the clock buffer shall not be asserted before VDD reaches VDDmin. Prior to VDDmin it is recommended to hold PWRGD low (less than 0.5V).

The power-up latency TSTABLE is to be less than 5 ms. This is the time from the assertion of the PWRGD signal to the time that stable clocks are output from the buffer chip. All differential outputs stopped in a Low/Low condition resulting from power down must be driven high in less than 300  $\mu$ s of PWRGD assertion to a voltage greater than 200 mV, as shown in Figure 2.



## PWRDN# Assertion

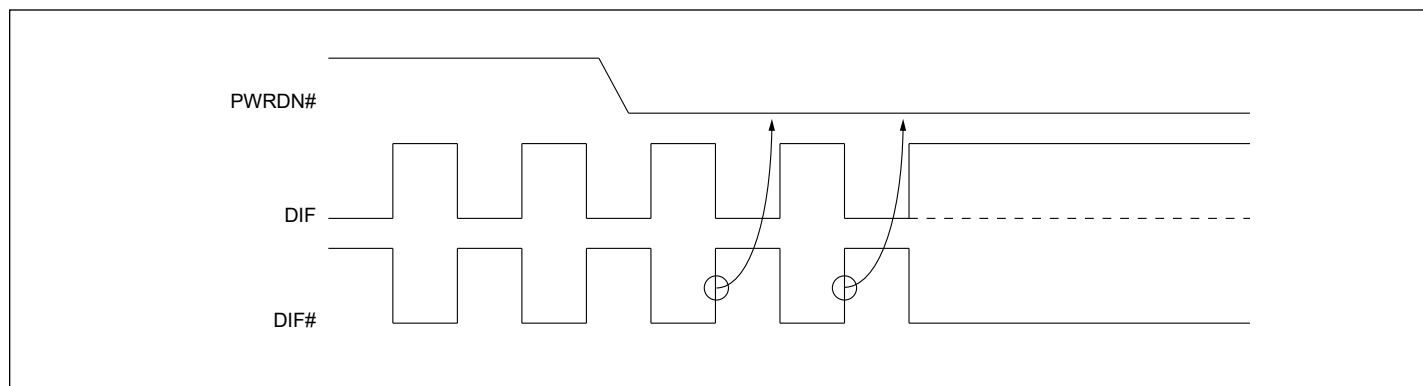


Figure 1. PWRDN# Assertion Timing

## PWRGD Assertion

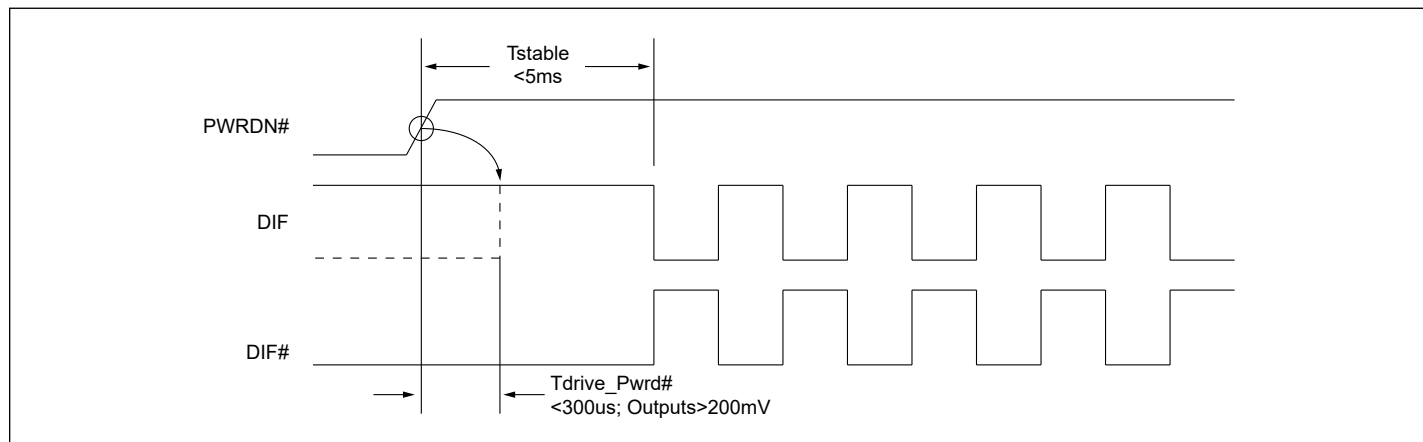


Figure 2. PWRGD Assertion Timing

## Output Enable Control

The PI6CG330440 has three methods for enabling and disabling outputs. In order for an output to be enabled, ALL three methods must enable the output. If ANY method disables the output, the output will be disabled. Clocks always start and stop in a glitch free manner, meaning duty cycle requirements are still met.

The first is the traditional method of OE# pins that are used for PCI Express clock enabling at the PCIe connector. Each of the 7 dedicated 100MHz clock outputs can be enabled or disabled with the OE[6:0]# pins individually. The OE# pin must be pulled low to enable the output.

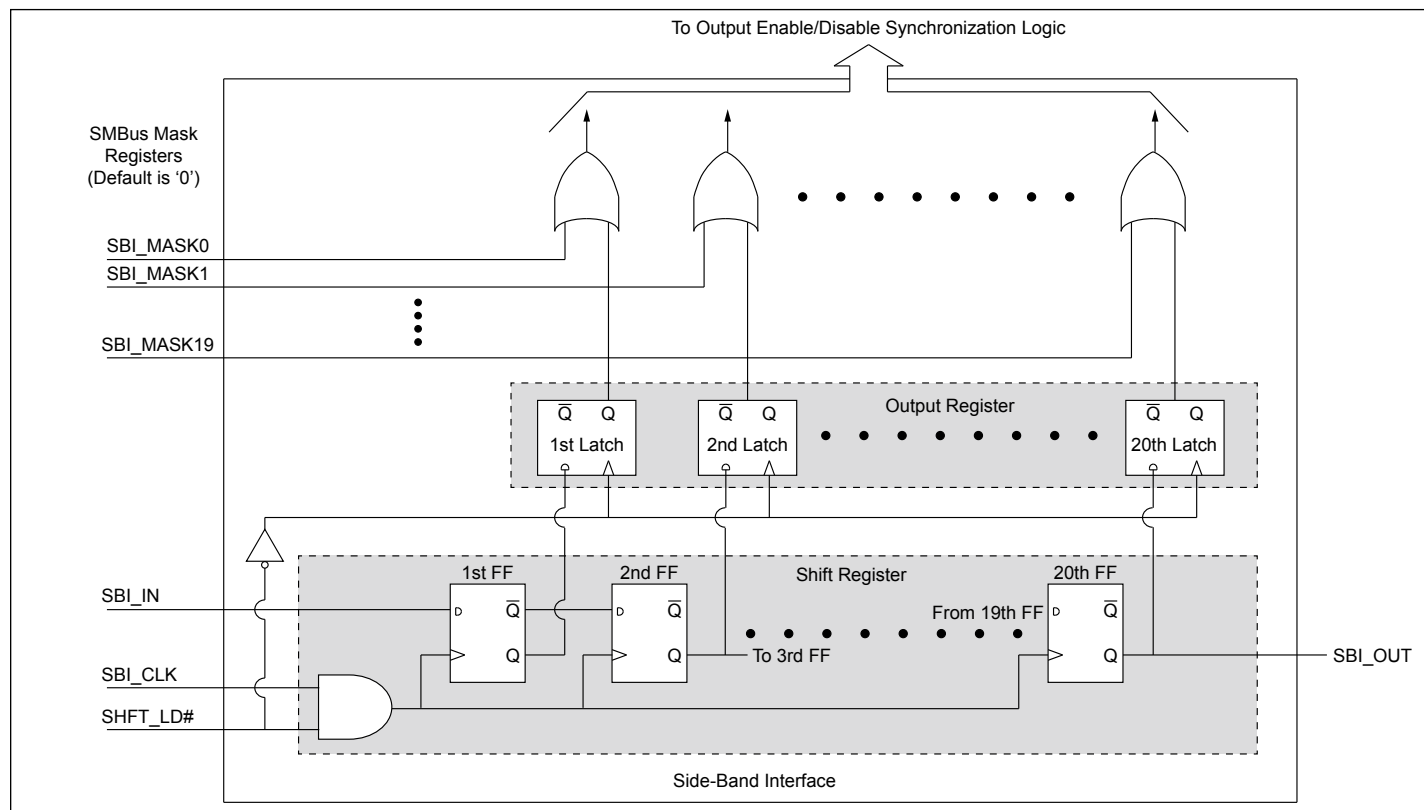
The second method is by using the SMBus output enable bits. Any of the 19 outputs have dedicated SMBus output enable bits in Bytes[0:2] of the SMBus register set that can enable or disable the clock outputs. The Output Enable bits in the SMBus registers are active high and are set to enable by default.

The third is using the Side Band Interface (SBI). This is a DB2000QL compatible method of enabling outputs using a hardware shift / load method. Refer to Power Management Tables for the truth table for enabling and disabling outputs via hardware and software. All three methods must be set to “enable” for the clock to be active on that pin.

### Side-Band Interface

This interface consists of SBI\_IN, SBI\_CLK, SHFT\_LD#, and SBI\_OUT pins. When the SHFT\_LD# pin is high, the rising edge of SBI\_CLK can shift DATA into the shift register. After shifting data, the falling edge of SHFT\_LD# loads the shift register contents to the output control register.

Since the PI6CG330440 has dedicated pins for the SBI, both SBI and the traditional SMBus methods are active at the same time. There are SMBus registers for masking off the disable function of the SBI interface. When set to a one, the mask register forces the SBI interface for its respective output to indicate ‘enabled’. This prevents accidentally disabling critical outputs when using the SBI. However the traditional SMBus enable bits and the OE# pins may still disable an output. If the application does not use the SBI, the SBI input pins may be tied ‘Low’. Figure 3 provides a high level functional description of the SBI.



**Figure 3. Side-band Interface Control Logic – Functional Description**

### Output Enable / Disable Priority

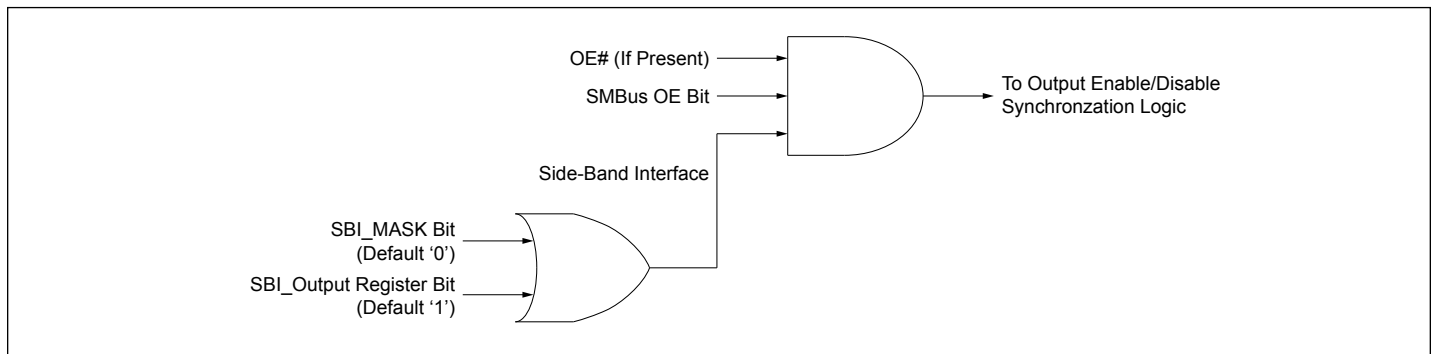
The PI6CG330440 requires that outputs be enabled by an 'AND' function of all methods of enabling the output. Figure 4 illustrates this. There are three enable/disable paths: OE# pin (if present), a SMBus OE bit and the Side-Band Interface. All three must indicate 'enable' for the output to be enabled. Conversely, any single enable/disable path can disable an output if it indicates 'disable'.

Additionally, the Side-Band Interface indicates a 'high' if the SBI\_Mask\_Bit OR the SBI\_Output Register Bit are 'high'. This means that the SBI\_MASK\_Bit can prevent the SBI interface from disabling an output. Note that the SBI\_MASK\_Bits are SMBus registers. The shift order follows the order of the SMBus enable bits in Byte[2:0] as shown in Figure 5. The first bit shifted in would be the output enable for the PFT\_OUT, which is in Byte 2 bit 3. The last bit shifted in would be the output enable for 100M0, which is in Byte 0, bit 0.

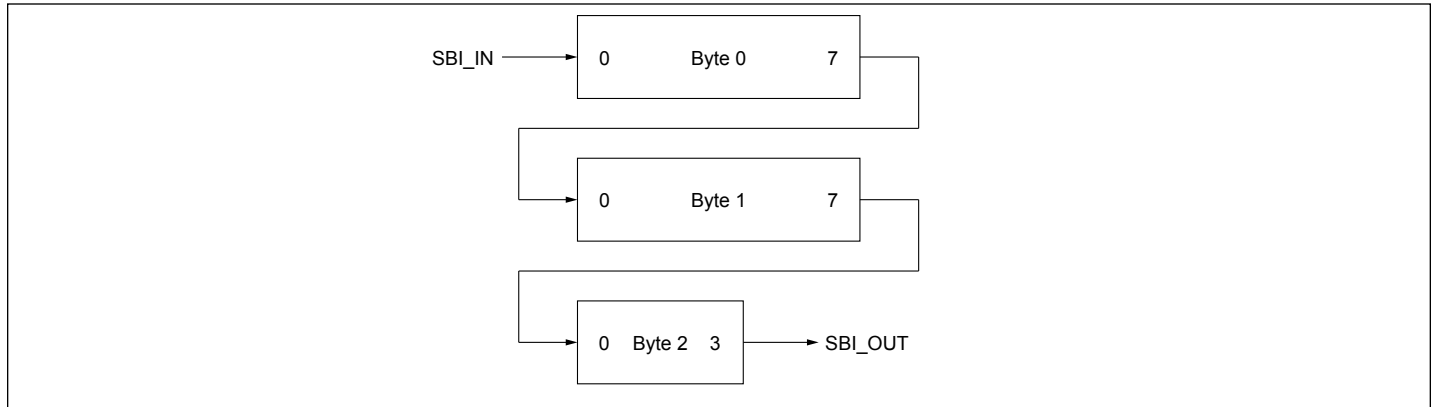
The SMBus registers for the SBI Output and SBI\_Mask follow the same bit order. Note that the SBI Output register contains the value latched from the shift register. Software must apply the SBI Mask bits to this value to get the output of the Side-Band Interface OR gate in Figure 4. Figure 6 shows the basic timing of the side-band interface. The SHFT\_LD# pin goes high to enable the SBI\_CLK input. Next, the rising edge of SBI\_CLK clocks SBI\_IN data into the shift register. After the 20th clock, stop the clock low and drive the SHFT\_LD# pin low. The falling edge of SHFT\_LD# latches the shift register contents to the output control register, enabling or disabling the outputs. Always shift 20 bits of data into the shift register to control the outputs.

The SBI interface supports clock rates up to 25MHz. The PI6CG330440 allows two SBI connection topologies – star and daisy chain. In a star topology, multiple devices may share SBI\_CLK and SBI\_IN pins. In this topology, each PI6CG330440 has a dedicated SHFT\_LD# pin. In a daisy-chain topology, the SBI\_OUT of one device connects to the SBI\_IN device of a downstream device. When using the daisy chain topology, the user must shift a complete set of bits for the combined devices. Two daisy-chained PI6CG330440 devices require shifting of 40 bits. When the SHFT\_LD# pin is low, the SBI interface ignores any activity on the SBI\_CLK and SBI\_IN pins. Figure 7 illustrates a star topology connection for the PI6CG330440 SBI interface. The star topology allows independent configuration of each device. For PI6CG330440, this means shifting 20 bits at a time. A disadvantage is that a separate SHFT\_LD# pin is required for each device.

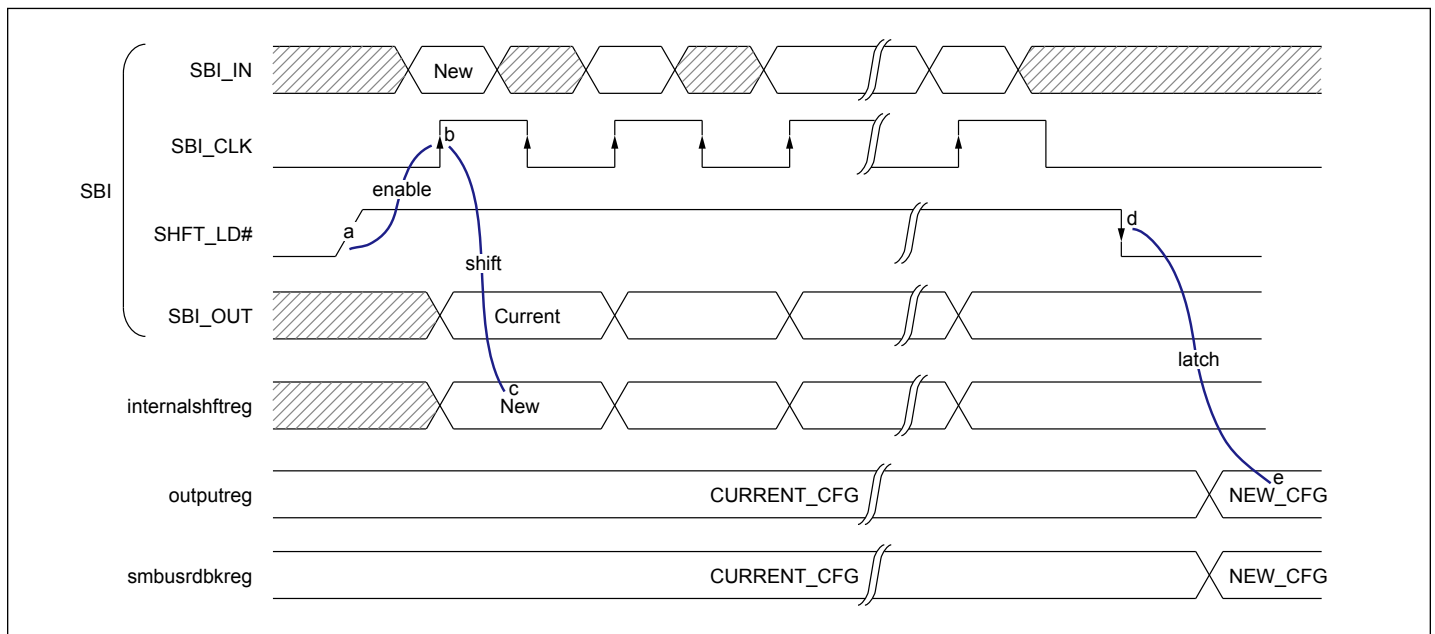
The daisy chain topology allows configuration of any number of devices with only three signals from the SBI controller. It utilizes the SBI\_OUT pin of one device to drive the SBI\_IN pin of the next device in the daisy chain. Users must take care to shift the proper number of bits in this configuration. For the example shown in Figure 8, the SBI bit stream consists of 40 bits.



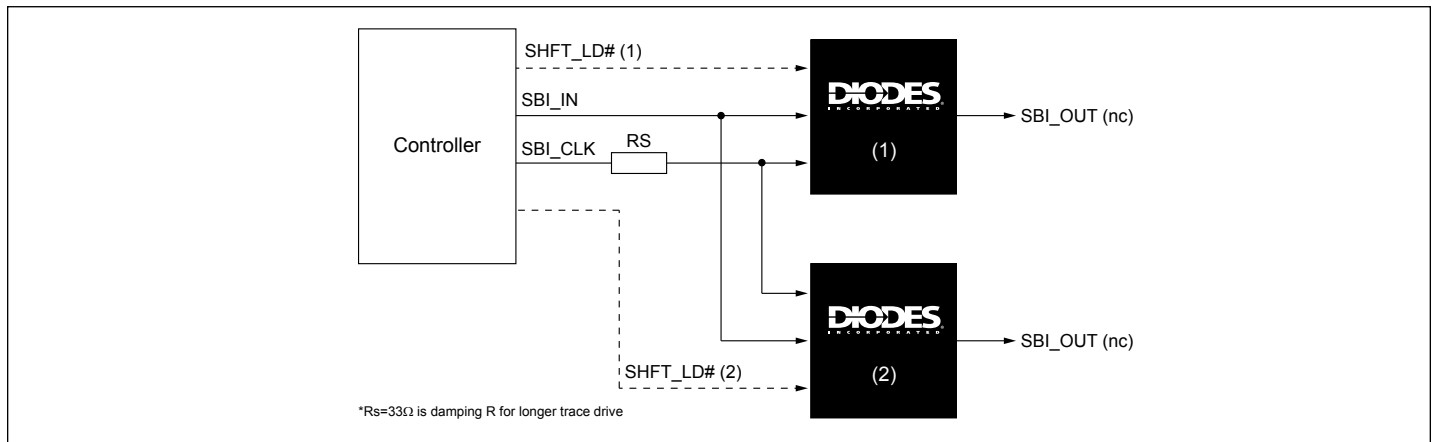
**Figure 4. Output Enable Logic (per output)**



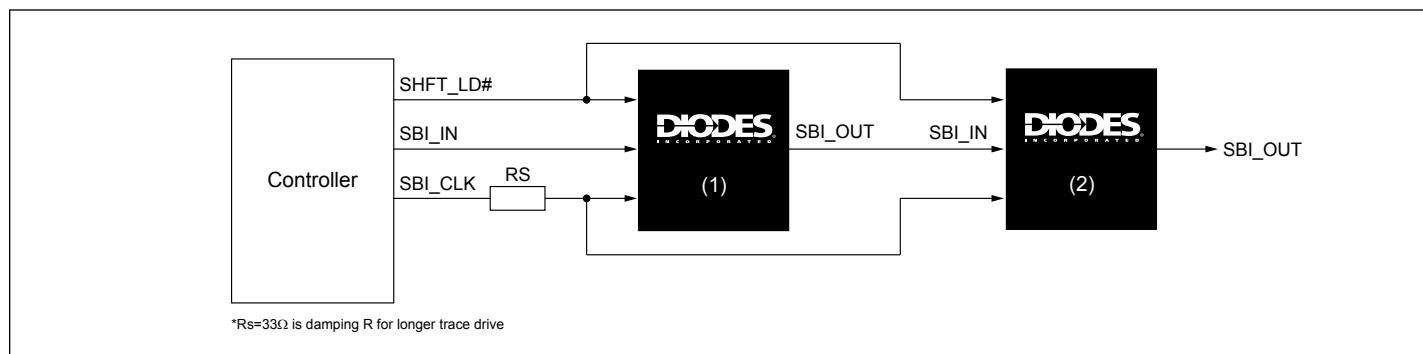
**Figure 5. Side-Band Shift Order**



**Figure 6. Side Band Interface Functional Timing**



**Figure 7. Star SBI Topology**



**Figure 8. Daisy-Chain SBI Topology**

## Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

|                                                      |                        |
|------------------------------------------------------|------------------------|
| Storage Temperature.....                             | -65°C to +150°C        |
| Supply Voltage to Ground Potential, $V_{DDXX}$ ..... | -0.5V to +4.0V         |
| Input Control Pins Voltage .....                     | -0.5V to $V_{DD}+0.5V$ |
| CLK+/- pins .....                                    | -0.5V to 2.5V          |
| SMBus, Input High Voltage .....                      | 3.6V                   |
| ESD Protection (HBM) .....                           | 2000V                  |
| Junction Temperature .....                           | 125 °C max             |

### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## Operating Conditions

Temperature =  $T_A$ ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol                              | Parameters                                                | Conditions                                           | Min.                            | Typ. | Max.  | Units |
|-------------------------------------|-----------------------------------------------------------|------------------------------------------------------|---------------------------------|------|-------|-------|
| V <sub>DD</sub> , V <sub>DD_A</sub> | Power Supply Voltage                                      |                                                      | 3.135                           | 3.3  | 3.465 | V     |
| I <sub>DDMXCK</sub>                 | Normal Operating Mode Power Supply Current <sup>(1)</sup> | V <sub>DDMXCK</sub> , MXCK[8:0] at 100MHz            |                                 | 70   | 105   | mA    |
| I <sub>DD100M</sub>                 |                                                           | V <sub>DD100M</sub> , 100M[6:0]                      |                                 | 56   | 84    | mA    |
| I <sub>DDXTAL</sub>                 |                                                           | V <sub>DDXTAL</sub> , 25MHz Xtal                     |                                 | 18   | 27    | mA    |
| I <sub>DDPT</sub>                   |                                                           | V <sub>DDPT</sub> , PFT circuit active               |                                 | 0.5  | 0.75  | mA    |
|                                     |                                                           | V <sub>DDPT</sub> , PFT circuit not used (no PFT_IN) |                                 | 0.5  | 0.75  | mA    |
| I <sub>DDA25M</sub>                 |                                                           | V <sub>DDA25M</sub> , 25M[2:0] on                    |                                 | 30   | 45    | mA    |
| I <sub>DDA100M</sub>                |                                                           | V <sub>DDA100M</sub> , 100M[6:0] on, SSC on          |                                 | 30   | 45    | mA    |
| I <sub>DDMXCK</sub>                 |                                                           | 25MPG Mode Power Supply Current <sup>(2)</sup>       | V <sub>DDMXCK</sub> , MXCK[8:0] |      | 2.5   | 3.75  |
| I <sub>DD100M</sub>                 | V <sub>DD100M</sub> , 100M[6:0]                           |                                                      |                                 | 2.5  | 3.75  | mA    |
| I <sub>DDXTAL</sub>                 | V <sub>DDXTAL</sub> , 25MHz Xtal                          |                                                      |                                 | 3.5  | 5.25  | mA    |
| I <sub>DDPT</sub>                   | V <sub>DDPT</sub>                                         |                                                      |                                 | 0.5  | 0.75  | mA    |
| I <sub>DDA25M</sub>                 | V <sub>DDA25M</sub> , 25M[2] on                           |                                                      |                                 | 25   | 37.5  | mA    |
| I <sub>DDA100M</sub>                | V <sub>DDA100M</sub>                                      |                                                      |                                 | 0.5  | 0.75  | mA    |
| I <sub>DDMXCK</sub>                 | Power Down Mode Power Supply Current <sup>(3)</sup>       | V <sub>DDMXCK</sub> , MXCK[8:0]                      |                                 | 2.5  | 3.75  | mA    |
| I <sub>DD100M</sub>                 |                                                           | V <sub>DD100M</sub> , 100M[6:0]                      |                                 | 2.5  | 3.75  | mA    |
| I <sub>DDXTAL</sub>                 |                                                           | V <sub>DDXTAL</sub> , 25MHz Xtal                     |                                 | 4    | 6     | mA    |
| I <sub>DDPT</sub>                   |                                                           | V <sub>DDPT</sub>                                    |                                 | 0.5  | 0.75  | mA    |
| I <sub>DDA25M</sub>                 |                                                           | V <sub>DDA25M</sub> , 25M[2]off                      |                                 | 10   | 13.5  | mA    |
| I <sub>DDA100M</sub>                |                                                           | V <sub>DDA100M</sub>                                 |                                 | 0.5  | 0.75  | mA    |
| T <sub>A</sub>                      | Ambient Temperature                                       | Industrial grade                                     | −40                             |      | 85    | °C    |

### Note:

1. PWRGD/PWRGDN# = 1, all outputs enabled.
2. PWRGD/PWRGDN# = 0, 25MPG = 1.
3. PWRGD/PWRGDN# = 0, 25MPG = 0.

## Input Electrical Characteristics

| Symbol                  | Parameters                                   | Conditions                    | Min. | Typ. | Max. | Units |
|-------------------------|----------------------------------------------|-------------------------------|------|------|------|-------|
| R <sub>pu</sub>         | Internal pull up resistance                  |                               |      | 120  |      | KΩ    |
| R <sub>dn</sub>         | Internal pull down resistance                |                               |      | 120  |      | KΩ    |
| R <sub>dn_PFT_IN#</sub> | Internal resistor to bias at 0.5V on PFT_IN# | Use internal resistor divider |      | 50   |      | KΩ    |
| R <sub>dn_PFT_IN</sub>  | Internal pull down resistor on PFT_IN        |                               |      | 50   |      | KΩ    |
| L <sub>PIN</sub>        | Pin inductance                               |                               |      |      | 7    | nH    |

## Crystal Characteristics

| Symbol             | Parameters                   | Min.        | Typ. | Max. | Units |
|--------------------|------------------------------|-------------|------|------|-------|
| OSCmode            | Mode of Oscillation          | Fundamental |      |      | –     |
| FREQ               | Frequency                    |             | 25   |      | MHz   |
| ESR <sup>(1)</sup> | Equivalent Series Resistance |             |      | 50   | Ω     |
| Cload              | Load Capacitance             |             | 8    |      | pF    |
| Cshunt             | Shunt Capacitance            |             |      | 7    | pF    |
| –                  | Drive Level                  |             |      | 200  | μW    |

### Note:

1. ESR value is dependent upon frequency of oscillation

## SMBus Electrical Characteristics

Temperature = T<sub>A</sub>; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol               | Parameters               | Conditions                       | Min.                        | Typ. | Max. | Units |
|----------------------|--------------------------|----------------------------------|-----------------------------|------|------|-------|
| V <sub>DDSMB</sub>   | Nominal bus voltage      |                                  | 2.7                         |      | 3.6  | V     |
| V <sub>IHSMB</sub>   | SMBus Input High Voltage | SMBus, V <sub>DDSMB</sub> = 3.3V | 2.1                         |      | 3.6  | V     |
|                      |                          | SMBus, V <sub>DDSMB</sub> < 3.3V | 0.65*<br>V <sub>DDSMB</sub> |      |      |       |
| V <sub>ILSMB</sub>   | SMBus Input Low Voltage  | SMBus, V <sub>DDSMB</sub> = 3.3V |                             |      | 0.6  | V     |
|                      |                          | SMBus, V <sub>DDSMB</sub> < 3.3V |                             |      | 0.6  |       |
| I <sub>SMBSINK</sub> | SMBus sink current       | SMBus, at V <sub>OLSMB</sub>     | 4                           |      |      | mA    |
| V <sub>OLSMB</sub>   | SMBus Output Low Voltage | SMBus, at I <sub>SMBSINK</sub>   |                             |      | 0.4  | V     |

### SMBus Standard Mode at 100kb/s (100k Class)

|                     |                           |                        |     |  |     |     |
|---------------------|---------------------------|------------------------|-----|--|-----|-----|
| f <sub>MAXSMB</sub> | SMBus operating frequency | Maximum frequency      |     |  | 100 | kHz |
| t <sub>BUF</sub>    | Bus Free Time             | Between STOP and START | 4.7 |  |     | us  |
| t <sub>HD_STA</sub> | Hold Time                 | After (REPEATED) START | 4   |  |     | us  |
| t <sub>SU_STA</sub> | Setup Time                | REPEATED START         | 4.7 |  |     | us  |
| t <sub>SU_STO</sub> | Setup Time                | STOP                   | 4   |  |     | us  |
| t <sub>HD_DAT</sub> | Hold Time                 | Data                   | 300 |  |     | ns  |

## SMBus Electrical Characteristics Cont.

Temperature = T<sub>A</sub>; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol                                         | Parameters                | Conditions                                                   | Min. | Typ. | Max. | Units |
|------------------------------------------------|---------------------------|--------------------------------------------------------------|------|------|------|-------|
| t <sub>SU_DAT</sub>                            | Setup Time                | Data                                                         | 250  |      |      | ns    |
| t <sub>TIMEOUT</sub>                           | Timeout                   | Detect SMBDAT Low                                            | 25   |      | 35   | ms    |
| t <sub>TIMEOUT</sub>                           | Timeout                   | Detect Clock Low                                             | 25   |      | 35   | ms    |
| t <sub>LOW</sub>                               | Clock Low Period          |                                                              | 4.7  |      |      | us    |
| t <sub>HIGH</sub>                              | Clock High Period         |                                                              | 4    |      | 50   | us    |
| t <sub>RMSB</sub>                              | SMBus rise time           | (Max V <sub>IL</sub> - 0.15) to (Min V <sub>IH</sub> + 0.15) |      |      | 1000 | ns    |
| t <sub>FMSB</sub>                              | SMBus fall time           | (Min V <sub>IH</sub> + 0.15) to (Max V <sub>IL</sub> - 0.15) |      |      | 300  | ns    |
| t <sub>POR</sub>                               | Time after power on reset | Power on and PWRGD/PWRDN# = 1                                |      |      | 5    | ms    |
| <b>SMBus Fast Mode at 400kb/s (400k Class)</b> |                           |                                                              |      |      |      |       |
| f <sub>MAXSMB</sub>                            | SMBus operating frequency | Maximum frequency                                            |      |      | 400  | kHz   |
| t <sub>BUF</sub>                               | Bus Free Time             | Between STOP and START                                       | 1.3  |      |      | us    |
| t <sub>HD_STA</sub>                            | Hold Time                 | After (REPEATED) START                                       | 0.6  |      |      | us    |
| t <sub>SU_STA</sub>                            | Setup Time                | REPEATED START                                               | 0.6  |      |      | us    |
| t <sub>SU_STO</sub>                            | Setup Time                | STOP                                                         | 0.6  |      |      | us    |
| t <sub>HD_DAT</sub>                            | Hold Time                 | Data                                                         | 300  |      |      | ns    |
| t <sub>SU_DAT</sub>                            | Setup Time                | Data                                                         | 100  |      |      | ns    |
| t <sub>TIMEOUT</sub>                           | Timeout                   | Detect SMBDAT Low                                            | 25   |      | 35   | ms    |
| t <sub>TIMEOUT</sub>                           | Timeout                   | Detect Clock Low                                             | 25   |      | 35   | ms    |
| t <sub>LOW</sub>                               | Clock Low Period          |                                                              | 1.3  |      |      | us    |
| t <sub>HIGH</sub>                              | Clock High Period         |                                                              | 0.6  |      | 50   | us    |
| t <sub>RMSB</sub>                              | SMBus rise time           | (Max V <sub>IL</sub> - 0.15) to (Min V <sub>IH</sub> + 0.15) |      |      | 300  | ns    |
| t <sub>FMSB</sub>                              | SMBus fall time           | (Min V <sub>IH</sub> + 0.15) to (Max V <sub>IL</sub> - 0.15) |      |      | 300  | ns    |
| t <sub>POR</sub>                               | Time after power on reset | Power on and PWRGD/PWRDN# = 1                                |      |      | 5    | ms    |

### Note:

1. After this period, the first clock is generated.
2. The device maintains 300ns data hold time for backwards compatibility with the SMBus 2.0 specification. Newer versions of the SMBus specification call out 0ns data hold time for both 100kHz and 400kHz classes.
3. The device provided additional SMBus protection by implementing a timeout for SMBDATA being held low in excess of t<sub>TIMEOUT</sub>, in addition to the SMBCLK low timeout.
4. Devices participating in a transfer can abort the transfer in progress and release the bus when any single clock low interval exceeds the value of t<sub>TIMEOUT</sub>, Minimum. After the master in a transaction detects this condition, it must generate a stop condition within or after the current data byte in the transfer process. Devices that have detected this condition must reset their communication and be able to receive a new START condition no later than t<sub>TIMEOUT</sub>, Maximum. Typical device examples include the host controller, and embedded controller, and most devices that can master the SMBus. Some simple devices do not contain a clock low drive circuit; this simple kind of device typically may reset its communications port after a start or a stop condition. A timeout condition can only be ensured if the device that is forcing the timeout holds the SMBCLK low for t<sub>TIMEOUT</sub>, Maximum or longer.
5. t<sub>HIGH</sub>, Maximum provides a simple guaranteed method for masters to detect bus idle conditions. A master can assume that the bus is free if it detects that the clock and data signals have been high for greater than t<sub>HIGH</sub>, Maximum.



## LVC MOS DC Electrical Characteristics

Temperature =  $T_A$ ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol    | Parameters                        | Conditions                                                     | Min. | Typ.       | Max.           | Units   |
|-----------|-----------------------------------|----------------------------------------------------------------|------|------------|----------------|---------|
| $V_{IH}$  | Input High Voltage                | Single-ended inputs, except trilevel pins                      | 2    |            | $V_{DD} + 0.3$ | V       |
| $V_{IL}$  | Input Low Voltage                 | Single-ended inputs, except trilevel pins                      | -0.3 |            | 0.8            | V       |
| $V_{IH}$  | Input High Voltage                | Single-ended trilevel inputs                                   | 2.5  |            | $V_{DD} + 0.3$ | V       |
| $V_{IM}$  | Input Mid Voltage                 | Single-ended trilevel inputs                                   | 1.2  | $V_{DD}/2$ | 1.8            | V       |
| $V_{IL}$  | Input Low Voltage                 | Single-ended trilevel inputs                                   | -0.3 |            | 0.8            | V       |
| $I_{IH}$  | Input High Current                | Single-ended inputs, $V_{IN} = V_{DD}$                         |      |            | 5              | $\mu A$ |
|           |                                   | Single-ended inputs with pull down resistor, $V_{IN} = V_{DD}$ |      |            | 50             | $\mu A$ |
| $I_{IL}$  | Input Low Current                 | Single-ended inputs, $V_{IN} = 0V$                             | -5   |            |                | $\mu A$ |
|           |                                   | Single-ended inputs with pull up resistor, $V_{IN} = 0V$       | -50  |            |                | $\mu A$ |
| $C_{IN}$  | Input Capacitance <sup>(1)</sup>  | Logic inputs, except differential inputs                       |      |            | 4.5            | pF      |
|           |                                   | Differential clock inputs                                      | 1.5  |            | 2.7            | pF      |
| $C_{OUT}$ | Output Capacitance <sup>(1)</sup> | Output pin capacitance                                         |      |            | 4.5            | pF      |

## LVC MOS AC Electrical Characteristics

Temperature =  $T_A$ ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol      | Parameters            | Conditions                                                                                        | Min. | Typ. | Max. | Units   |
|-------------|-----------------------|---------------------------------------------------------------------------------------------------|------|------|------|---------|
| $f_{IN}$    | Input Frequency       |                                                                                                   |      | 25   |      | MHz     |
| $t_{STAB}$  | Clock Stabilization   | From VDD power-up and after input clock stabilization or de-assertion of PWRDN# to valid outputs. |      |      | 5    | ms      |
| $t_{PDLAT}$ | PD# de-assertion      | Differential outputs enable after PD# de-assertion                                                |      | 100  | 200  | $\mu s$ |
| $t_{OELAT}$ | Output enable latency | 100M start after OE# assertion<br>100M stop after OE# deassertion                                 | 4    |      | 10   | clocks  |
| $t_{PDLAT}$ | PWRDN# de-assertion   | Differential outputs enable after PWRDN# de-assertion                                             |      | 10   | 50   | $\mu s$ |
| $t_{RF}$    | Rise and Fall Time    | Control inputs <sup>(2)</sup>                                                                     |      |      | 5    | ns      |

### Note:

- Guaranteed by design and characterization, not 100% tested in production.
- Control input must be monotonic from 20% to 80% of input swing.

## PFT Differential Input Characteristics<sup>(1)</sup>

Temperature = T<sub>A</sub>; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol             | Parameters                              | Conditions                                                    | Min. | Typ. | Max. | Units |
|--------------------|-----------------------------------------|---------------------------------------------------------------|------|------|------|-------|
| f <sub>IN</sub>    | Input Frequency                         |                                                               |      | 25   |      | MHz   |
| V <sub>IHDIF</sub> | Diff. Input High Voltage <sup>(3)</sup> | IN+, IN-, single-end measurement                              | 330  |      | 1150 | mV    |
| V <sub>ILDIF</sub> | Diff. Input Low Voltage <sup>(3)</sup>  | IN+, IN-, single-end measurement                              | -300 | 0    | 300  | mV    |
| V <sub>SWING</sub> | Diff. Input Swing Voltage               | Peak to peak value (V <sub>IHDIF</sub> - V <sub>ILDIF</sub> ) | 200  |      | 2000 | mV    |
| V <sub>COM</sub>   | Common Mode Voltage                     |                                                               | 100  |      | 1000 | mV    |
| t <sub>RF</sub>    | Diff. Input Slew Rate <sup>(2)</sup>    |                                                               | 0.7  |      |      | V/ns  |
| I <sub>IN</sub>    | Diff. Input Leakage Current             | V <sub>IN</sub> = V <sub>DD</sub> , V <sub>IN</sub> = GND     | -50  |      | 100  | uA    |
| t <sub>DC</sub>    | Diff. Input Duty Cycle                  | Measured differentially                                       | 45   |      | 55   | %     |
| t <sub>jC-c</sub>  | Diff. Input Cycle to cycle jitter       | Measured differentially                                       |      |      | 125  | ps    |

### Note:

- Guaranteed by design and characterization, not 100% tested in production
- Slew rate measured through +/-75mV window centered around differential zero
- The device can be driven by a single-ended clock by driving the true clock and biasing the complement clock input to the V<sub>bias</sub>, where V<sub>bias</sub> is (V<sub>IH</sub>-V<sub>IL</sub>)/2

## HCSL Output Characteristics

Temperature = T<sub>A</sub>; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol                                                                                       | Parameters                                  | Conditions                                              | Min.                 | Typ. | Max.                | Units |
|----------------------------------------------------------------------------------------------|---------------------------------------------|---------------------------------------------------------|----------------------|------|---------------------|-------|
| <b>Outputs Driving High Impedance Receiver</b>                                               |                                             |                                                         |                      |      |                     |       |
| V <sub>MAX</sub>                                                                             | Maximum Output Voltage <sup>(1,5,6)</sup>   | Measurement on single ended signal using absolute value | 660                  | 800  | 1150                | mV    |
| V <sub>MIN</sub>                                                                             | Minimum Output Voltage <sup>(1,5,6)</sup>   |                                                         | -150                 | 20   | 150                 | mV    |
| V <sub>cross abs</sub>                                                                       | Absolute Crossing Point Voltage             | Scope averaging off.                                    | 250                  | 400  | 500                 | mV    |
| V <sub>cross rel</sub>                                                                       | Relative Crossing Point Voltage             | Scope averaging off.                                    |                      | 0    | 100                 | mV    |
| t <sub>RF</sub>                                                                              | Slew Rate <sup>(1,2,3)</sup>                | Scope averaging on, 10 inch trace                       | 2                    | 3.0  | 4                   | V/ns  |
| D <sub>tRF</sub>                                                                             | Slew Rate Matching <sup>(1,2,4)</sup>       | Scope averaging on, 10 inch trace                       |                      | 6    | 19                  | %     |
| <b>Outputs Driving Terminated Receiver (Double Termination, see test setup in Figure 11)</b> |                                             |                                                         |                      |      |                     |       |
| V <sub>MAX</sub>                                                                             | Maximum Output Voltage <sup>(1,5,6)</sup>   | Measurement on single ended signal using absolute value |                      |      | V <sub>OH</sub> +75 | mV    |
| V <sub>MIN</sub>                                                                             | Minimum Output Voltage <sup>(1,5,6)</sup>   |                                                         | V <sub>OL</sub> - 75 |      |                     | mV    |
| V <sub>OH</sub>                                                                              | Output High Voltage                         |                                                         | 225                  |      | 270                 | mV    |
| V <sub>OL</sub>                                                                              | Output Low Voltage                          |                                                         | 10                   |      | 150                 | mV    |
| V <sub>cross abs</sub>                                                                       | Absolute Crossing Point Voltage             | Scope averaging off.                                    | 130                  |      | 200                 | mV    |
| Diff-Z                                                                                       | Output Differential Impedance               | Measured at V <sub>OL</sub> / V <sub>OH</sub>           | 85 - 5%              |      | 85 + 5%             | Ω     |
| Diff-Z <sub>CROSS-ING</sub>                                                                  | Output Differential Impedance               | Measured during a transition                            | 85 - 20%             |      | 85 + 20%            | Ω     |
| t <sub>SKWGP</sub>                                                                           | Output Skew Within a Group <sup>(1,2)</sup> | Groups are 25M[2:0], MXCK[8:0], and 100M[6:0]           |                      | 25   |                     | ps    |

## HCSL Output Characteristics Cont.

Temperature = T<sub>A</sub>; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol                  | Parameters                      | Conditions                                                                            | Min. | Typ. | Max. | Units |
|-------------------------|---------------------------------|---------------------------------------------------------------------------------------|------|------|------|-------|
| t <sub>SKWEG-P2GP</sub> | Output Skew Across Groups (1,2) | Across 25M[2:0] and MXCK[8:0] set to 25MHz or 100M[6:0] and MXCK[8:0] set to 100MHz   |      | 100  |      | ps    |
| t <sub>DC100M</sub>     | Duty Cycle                      | 100MHz Outputs and MXCLK outputs set to 100MHz.                                       | 45   |      | 55   | %     |
| t <sub>DC25M</sub>      | Duty Cycle                      | 25MHz Outputs and MXCLK outputs set to 25MHz with XTAL as source                      | 45   |      | 55   | %     |
| t <sub>DC100M</sub>     | Duty Cycle                      | 25MHz Outputs and MXCLK outputs set to 25MHz with XO as source with 44/55% duty cycle | 45   |      | 55   | %     |
| t <sub>jC-c25M</sub>    | Cycle to cycle jitter (1,2)     | 25MHz Outputs and MXCLK outputs set to 25MHz                                          |      | 0.5  | 1    | ns    |
| t <sub>jC-c100M</sub>   | Cycle to cycle jitter (1,2)     | 100MHz Outputs and MXCLK outputs set to 100MHz                                        |      | 25   |      | ps    |

### Note:

1. Guaranteed by design and characterization, not 100% tested in production
2. Measured from differential waveform
3. Slew rate is measured through the V<sub>swing</sub> voltage range centered around differential 0V, within +/-150mV window
4. Slew rate matching is measured through +/-75mV window centered around differential zero
5. At default SMBus settings.
6. Includes 300mV of overshoot for V<sub>max</sub> and 300mV of undershoot for V<sub>min</sub>.

## PCIe Common Clock (CC) Architecture Jitter

| Symbol              | Parameters                    | Condition                                                                                 | Min. | Typ. | Max. | Spec Limit | Units     |
|---------------------|-------------------------------|-------------------------------------------------------------------------------------------|------|------|------|------------|-----------|
| t <sub>JPHASE</sub> | Integrated phase jitter (RMS) | PCIe 1.0                                                                                  |      | 20   | 60   | 86         | ps (pkpk) |
|                     |                               | PCIe 2.0 Low Band, 10kHz < f < 1.5MHz (PLL BW 5-16MHz or 8-5MHz, CDR = 10MHz)             |      | 0.06 | 0.15 | 3          | ps        |
|                     |                               | PCIe 2.0 High Band, 1.5MHz < f < Nyquist (50MHz); (PLL BW 5-16MHz or 8-5MHz, CDR = 10MHz) |      | 0.2  | 0.3  | 3.1        | ps        |
|                     |                               | PCIe 3.0 (PLL BW 2-4MHz or 2-5MHz, CDR= 10MHz)                                            |      | 0.07 | 0.12 | 1          | ps        |
|                     |                               | PCIe 4.0 (PLL BW 2-4MHz or 2-5MHz, CDR= 10MHz)                                            |      | 0.03 | 0.05 | 0.5        | ps        |
|                     |                               | PCIe 5.0                                                                                  |      | 0.03 | 0.05 | 0.08       | ps        |

### PCIe Independent Reference Clock Architecture Jitter

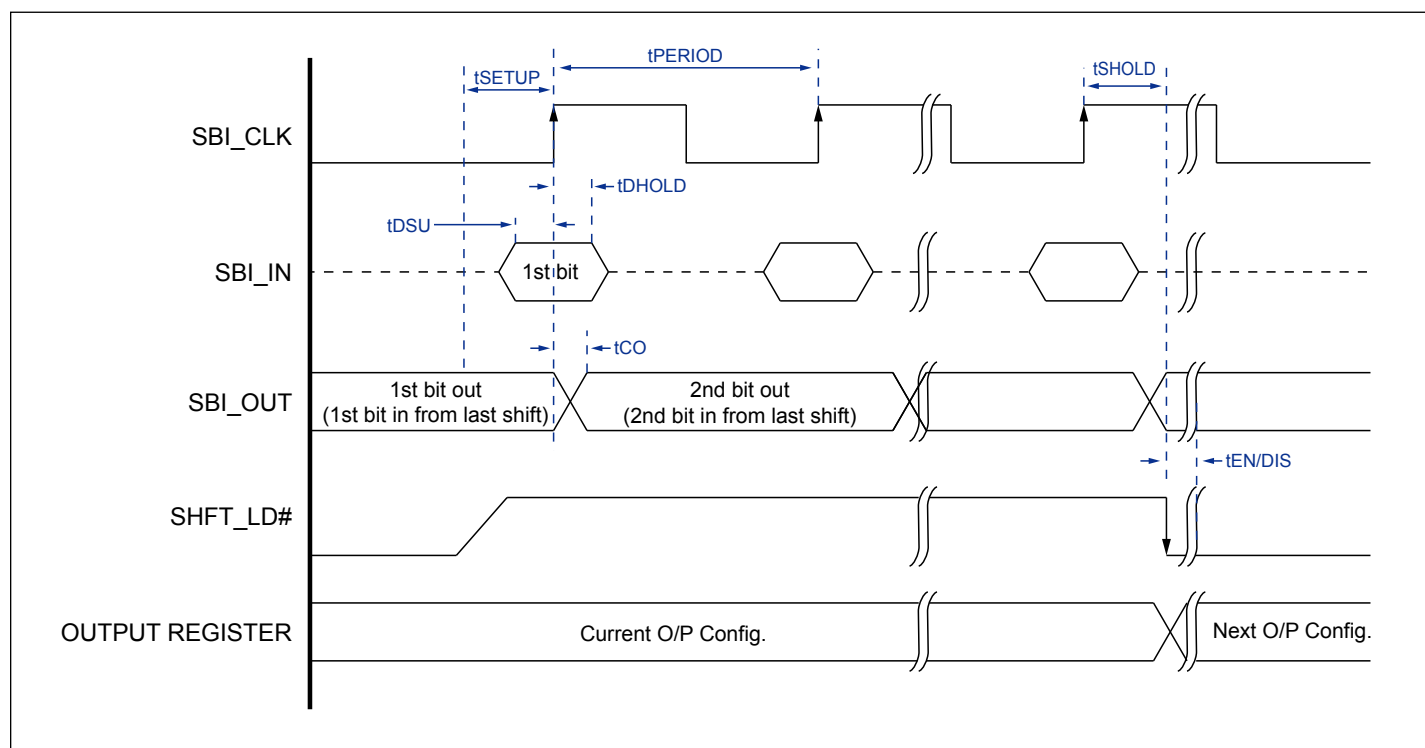
| Symbol              | Parameters                    | Condition                                           | Min. | Typ. | Max. | Spec Limit | Units |
|---------------------|-------------------------------|-----------------------------------------------------|------|------|------|------------|-------|
| t <sub>JPHASE</sub> | Integrated phase jitter (RMS) | PCIe 3.0 SRIS (PLL BW 2-4MHz or 2-5MHz, CDR= 10MHz) |      | 0.1  | 0.3  |            | ps    |
|                     |                               | PCIe 4.0 SRIS (PLL BW 2-4MHz or 2-5MHz, CDR= 10MHz) |      | 0.1  | 0.3  |            | ps    |
|                     |                               | PCIe 5.0 SRIS                                       |      | 0.03 | 0.1  |            | ps    |

## Side Band Signal Characteristics

| Symbol             | Parameters               | Condition                                                                                                              | Min. | Typ. | Max. | Units  |
|--------------------|--------------------------|------------------------------------------------------------------------------------------------------------------------|------|------|------|--------|
| $t_{PERIOD}$       | Clock Period             |                                                                                                                        | 40   |      |      | ns     |
| $t_{SETUP}$        | SHFT Setup Time to Clock | SHFT_LD# high to SBI_CLK rising edge                                                                                   | 10   |      |      | ns     |
| $t_{SHD}^{(1)}$    | SHFT Hold Time to Clock  | SHFT_LD# hold (high) after SBI_CLK rising edge (SBI_CLK to SHFT_LD# falling edge)                                      | 10   |      |      | ns     |
| $t_{DSU}^{(1)}$    | SBI_IN Setup Time        | SBI_IN setup to SBI_CLK rising edge                                                                                    | 5    |      |      | ns     |
| $t_{DHD}^{(1)}$    | SBI_IN Hold Time         | SBI_IN hold after SBI_CLK rising edge                                                                                  | 2    |      |      | ns     |
| $t_{COUT}^{(1)}$   | SBI_CLK to SBI_OUT       | SBI_CLK rising edge to SBI_OUT valid                                                                                   | 2    |      |      | ns     |
| $t_{EN}^{(1)}$     | Enable/Disable Time      | Delay from SHFT_LD# falling edge to next output configuration taking effect. Refers to device differential input clock | 4    |      | 10   | clocks |
| $t_{SLEW}^{(1,2)}$ | Slew Rate                | SBI_CLK input (between 20% and 80%)                                                                                    | 0.7  |      | 4    | V/ns   |

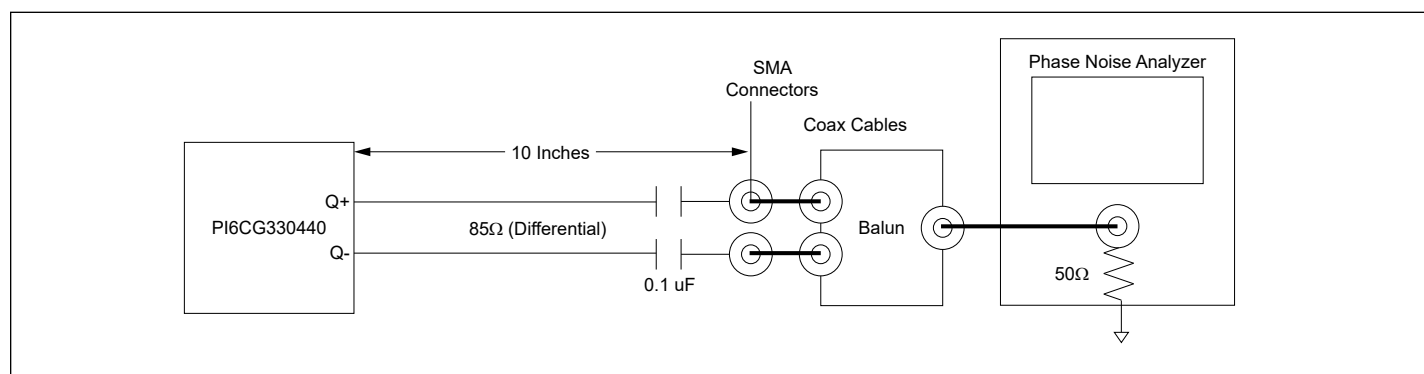
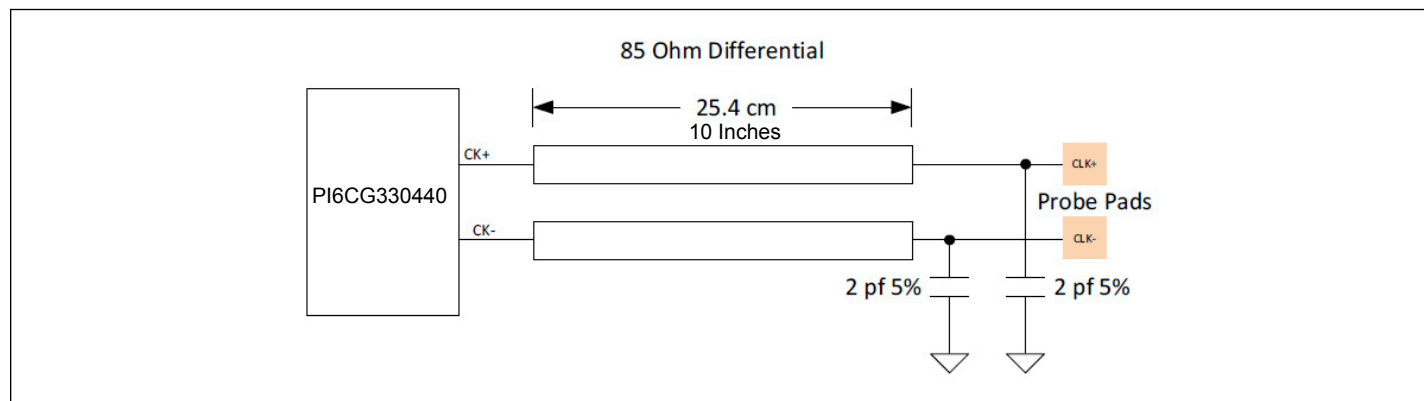
### Note:

1. Guaranteed by design and characterization, not 100% tested in production
2. Control input must be monotonic from 20% to 80% of input swing.

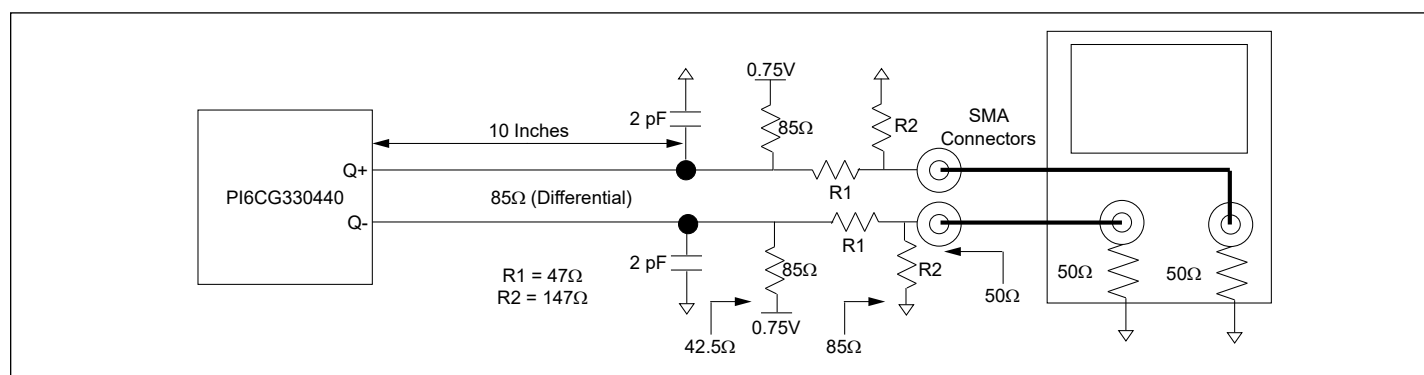


**Figure 9. Side Band Interface Timing**

## AC/DC Test Load



**Figure 10. Test Setup for PCIe Jitter Measurement**



**Figure 11. Test Setup for Double Termination**

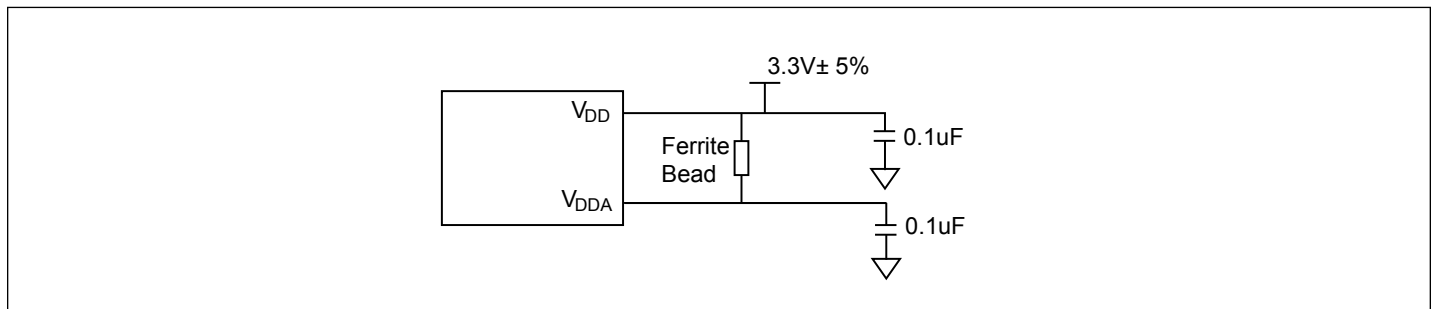
**PI6CG330440**

### Power Supply Noise Profile

| Symbol              | Parameters         | Condition                                | Min. | Typ. | Max. | Units |
|---------------------|--------------------|------------------------------------------|------|------|------|-------|
| V <sub>DD_AC</sub>  | Power Supply Noise | Single tone AC noise, swept              |      | 40   |      | mV    |
| V <sub>DDA_AC</sub> | Power Supply Noise | VDDA electrical noise > 20MHz.           |      | 20   |      | mV    |
| V <sub>DDXTAL</sub> | Power Supply Noise | VDDXTAL electrical noise 12kHz to 25MHz. |      | 20   |      | mV    |

**Note:**

1. Guaranteed by design and characterization, not 100% tested in production
2. Control input must be monotonic from 20% to 80% of input swing.



**Figure 12. Power Supply Filter**

## SMBus Serial Data Interface

PI6CG330440 is a slave only device that supports block read and block write protocol using a single 7-bit address and read/write bit as shown below.

Read and write block transfers can be stopped after any complete byte transfer.

## Address Assignment

SMBus Address Selection Table

| SMB_ADR1_tri | SMB_ADR0_tri | SMBus Address |
|--------------|--------------|---------------|
| L            | L            | D2            |
| L            | M            | D4            |
| L            | H            | D6            |
| M            | L            | B2            |
| M            | M            | B4            |
| M            | H            | B6            |
| H            | L            | BA            |
| H            | M            | BC            |
| H            | H            | BE            |

### How to Write

| 1 bit     | 7 bits | 1 bit | 1 bit | 8 bits                              | 1 bit | 8 bits                 | 1 bit | 8 bits                        | 1 bit |       | 8 bits               | 1 bit | 1 bit    |
|-----------|--------|-------|-------|-------------------------------------|-------|------------------------|-------|-------------------------------|-------|-------|----------------------|-------|----------|
| Start bit | Add.   | W(0)  | Ack   | Beginning<br>Byte loca-<br>tion = N | Ack   | Data Byte<br>count = X | Ack   | Beginning<br>Data Byte<br>(N) | Ack   | ..... | Data Byte<br>(N+X-1) | Ack   | Stop bit |

### How to Read

| 1 bit     | 7 bits  | 1 bit | 1 bit | 8 bits                              | 1 bit | 1 bit               | 7 bits  | 1 bit | 1 bit | 8 bits                 | 1 bit | 8 bits                        | 1 bit |
|-----------|---------|-------|-------|-------------------------------------|-------|---------------------|---------|-------|-------|------------------------|-------|-------------------------------|-------|
| Start bit | Address | W(0)  | Ack   | Beginning<br>Byte loca-<br>tion = N | Ack   | Repeat<br>Start bit | Address | R(1)  | Ack   | Data Byte<br>count = X | Ack   | Beginning<br>Data Byte<br>(N) | Ack   |

|       | 8 bits               | 1 bit | 1 bit    |
|-------|----------------------|-------|----------|
| ..... | Data Byte<br>(N+X-1) | NAck  | Stop bit |



### Byte 0: Output Enable Register 0

| Bit | Control Function | Description             | Type | Power Up Condition | 0        | 1       |
|-----|------------------|-------------------------|------|--------------------|----------|---------|
| 7   | OE_MXCK8         | Output Enable for MXCK8 | RW   | 1                  | Disabled | Enabled |
| 6   | OE_100M6         | Output Enable for 100M6 | RW   | 1                  | Disabled | Enabled |
| 5   | OE_100M5         | Output Enable for 100M5 | RW   | 1                  | Disabled | Enabled |
| 4   | OE_100M4         | Output Enable for 100M4 | RW   | 1                  | Disabled | Enabled |
| 3   | OE_100M3         | Output Enable for 100M3 | RW   | 1                  | Disabled | Enabled |
| 2   | OE_100M2         | Output Enable for 100M2 | RW   | 1                  | Disabled | Enabled |
| 1   | OE_100M1         | Output Enable for 100M1 | RW   | 1                  | Disabled | Enabled |
| 0   | OE_100M0         | Output Enable for 100M0 | RW   | 1                  | Disabled | Enabled |

### Byte 1: Output Enable Register 1

| Bit | Control Function | Description             | Type | Power Up Condition | 0        | 1       |
|-----|------------------|-------------------------|------|--------------------|----------|---------|
| 7   | OE_MXCK7         | Output Enable for MXCK7 | RW   | 1                  | Disabled | Enabled |
| 6   | OE_MXCK6         | Output Enable for MXCK6 | RW   | 1                  | Disabled | Enabled |
| 5   | OE_MXCK5         | Output Enable for MXCK5 | RW   | 1                  | Disabled | Enabled |
| 4   | OE_MXCK4         | Output Enable for MXCK4 | RW   | 1                  | Disabled | Enabled |
| 3   | OE_MXCK3         | Output Enable for MXCK3 | RW   | 1                  | Disabled | Enabled |
| 2   | OE_MXCK2         | Output Enable for MXCK2 | RW   | 1                  | Disabled | Enabled |
| 1   | OE_MXCK1         | Output Enable for MXCK1 | RW   | 1                  | Disabled | Enabled |
| 0   | OE_MXCK0         | Output Enable for MXCK0 | RW   | 1                  | Disabled | Enabled |

### Byte 2: Output Enable Register 2

| Bit | Control Function                | Description                               | Type | Power Up Condition | 0               | 1                |
|-----|---------------------------------|-------------------------------------------|------|--------------------|-----------------|------------------|
| 7   | MXCK_SEL                        | MXCK[8:0] Frequency Select                | RW   | 0                  | 100MHz          | 25MHz            |
| 6   | MXCK_SEL Control <sup>(1)</sup> | MXCK[8:0] Select control                  | RW   | 0                  | Pin control     | Register control |
| 5   | MXCK_SEL_RB                     | Readback of latched MXCK_SEL pin at PWRGD | R    | Latched            | 100MHz Selected | 25 MHz Selected  |
| 4   | Reserved                        | Reserved                                  |      | 0                  | -               | -                |
| 3   | OE_PFT_OUT                      | Output Enable for PFT_OUT                 | RW   | 1                  | Disabled        | Enabled          |
| 2   | OE_25M2                         | Output Enable for 25M2                    | RW   | 1                  | Disabled        | Enabled          |
| 1   | OE_25M1                         | Output Enable for 25M1                    | RW   | 1                  | Disabled        | Enabled          |
| 0   | OE_25M0                         | Output Enable for 25M0                    | RW   | 1                  | Disabled        | Enabled          |

**Note:** If MXCK\_SEL Control (bit 6) is set to '0' (default), MXCK[8:0] outputs are controlled with MXCK\_SEL\_100 pin. If MXCK\_SEL Control (bit 6) is set to '1' then MXCK[8:0] outputs are controlled with MXCK\_SEL bit (bit 7).

### Byte 3: PFT Control Register

| Bit | Control Function | Description                                    | Type | Power Up Condition | 0             | 1                      |
|-----|------------------|------------------------------------------------|------|--------------------|---------------|------------------------|
| 7   | PFT_LOST#_RB     | Realtime Readback of PFT_LOST#                 | R    | Realtime           | PFT_LOST# Low | PFT_LOST# High         |
| 6   | Stop_Update      | Stop Delta Frequency Update (Byte 4 and 5)     | RW   | 0                  | Disabled      | Enabled                |
| 5   | Clear_Reg        | Clear Delta Frequency Registers (Byte 4 and 5) | RW   | 0                  |               | All bits reset to 0 RW |
| 4   | Reserved         | Reserved                                       |      | 0                  |               |                        |
| 3   | Reserved         | Reserved                                       |      | 0                  |               |                        |
| 2   | Reserved         | Reserved                                       |      | 0                  |               |                        |
| 1   | Reserved         | Reserved                                       |      | 0                  |               |                        |
| 0   | Reserved         | Reserved                                       |      | 0                  |               |                        |

**Note:** Prior to reading the delta frequency between PFT\_IN and local 25MHz XO (Bytes 4 and 5), user should set bit 6 to prevent the case where one of the PFT Frequency Delta Registers is read before and the other after the internal update. This bit should be cleared after the read has been completed.

### Byte 4: PFT Frequency Delta Register 0 (Least Significant Byte)

| Bit | Control Function | Description           | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-----------------------|------|--------------------|---|---|
| 7   | PFT_DF7          | PFT – 25 MHz XO bit 7 | R    | Realtime           |   |   |
| 6   | PFT_DF6          | PFT – 25 MHz XO bit 6 | R    | Realtime           |   |   |
| 5   | PFT_DF5          | PFT – 25 MHz XO bit 5 | R    | Realtime           |   |   |
| 4   | PFT_DF4          | PFT – 25 MHz XO bit 4 | R    | Realtime           |   |   |
| 3   | PFT_DF3          | PFT – 25 MHz XO bit 3 | R    | Realtime           |   |   |
| 2   | PFT_DF2          | PFT – 25 MHz XO bit 2 | R    | Realtime           |   |   |
| 1   | PFT_DF1          | PFT – 25 MHz XO bit 1 | R    | Realtime           |   |   |
| 0   | PFT_DF0          | PFT – 25 MHz XO bit 0 | R    | Realtime           |   |   |

**Note:** Byte 4 and 5 contain frequency difference between the PFT clock and the local 25MHz reference in two's complement format with resolution (step size) of  $1\text{ns} \times (25\text{MHz} / 215) = 0.763 \text{ ppm}$ . Byte 4 contains the least significant byte.

### Byte 5: PFT Frequency Delta Register 1 (Most Significant Byte)

| Bit | Control Function | Description            | Type | Power Up Condition | 0        | 1        |
|-----|------------------|------------------------|------|--------------------|----------|----------|
| 7   | PFT_SIGN         | PFT – Sign Bit         | R    | Realtime           | Positive | Negative |
| 6   | PFT_DF14         | PFT – 25 MHz XO bit 14 | R    | Realtime           |          |          |
| 5   | PFT_DF13         | PFT – 25 MHz XO bit 13 | R    | Realtime           |          |          |
| 4   | PFT_DF12         | PFT – 25 MHz XO bit 12 | R    | Realtime           |          |          |
| 3   | PFT_DF11         | PFT – 25 MHz XO bit 11 | R    | Realtime           |          |          |
| 2   | PFT_DF10         | PFT – 25 MHz XO bit 10 | R    | Realtime           |          |          |
| 1   | PFT_DF9          | PFT – 25 MHz XO bit 9  | R    | Realtime           |          |          |
| 0   | PFT_DF8          | PFT – 25 MHz XO bit 8  | R    | Realtime           |          |          |

**Note:** Byte 4 and 5 contain frequency difference between the PFT clock and the local 25MHz reference in two's complement format with resolution (step size) of  $1\text{ns} \times (25\text{MHz} / 215) = 0.763\text{ ppm}$ . Byte 5 contains the most significant byte.

### Byte 6: SSC PLL Control Register

| Bit | Control Function     | Description                                                               | Type | Power Up Condition        | 0                                                                                        | 1                         |
|-----|----------------------|---------------------------------------------------------------------------|------|---------------------------|------------------------------------------------------------------------------------------|---------------------------|
| 7   | Reserved             | Reserved                                                                  |      | Reserved                  |                                                                                          |                           |
| 6   | Reserved             | Reserved                                                                  |      | Reserved                  |                                                                                          |                           |
| 5   | SSC_ENABLE_RB        | Readback of SSC_ENABLE pin for 100M[6:0] and MXCK[8:0] if MXCK_SEL is low | R    | Realtime                  | Bit[1:0]: SSC State<br>00: SSC Off<br>01: SSC = -0.3%<br>10: Reserved<br>11: SSC = -0.5% |                           |
| 4   |                      |                                                                           | R    | Realtime                  |                                                                                          |                           |
| 3   | SSC PLL Input Source | SSC source for 100M[6:0] and MXCK[8:0] if MXCK_SEL is low                 | RW   | 0                         | Xtal                                                                                     | Filter PLL <sup>(1)</sup> |
| 2   | SSC_Ctr              | SSC control for 100M[6:0] and MXCK[8:0] if MXCK_SEL is low                | RW   | 0                         | Enabled                                                                                  | Disabled                  |
| 1   | SSC_SEL              | 100M[6:0] and MXCK[8:0] if MXCK_SEL is low                                | RW   | Latch SSC pin on power-up | Bit[1:0]: SSC State<br>00: SSC Off<br>01: SSC = -0.3%<br>10: Reserved<br>11: SSC = -0.5% |                           |
| 0   |                      | 100M[6:0] and MXCK[8:0] if MXCK_SEL is low                                | RW   | Latch SSC pin on power-up |                                                                                          |                           |

**Note:** 1. When “SSC PLL Input Source” selects “Filter PLL” option, there’s no guarantee the outputs will be synchronized.

### Byte 7: OE# Pin Realtime Readback Control Register

| Bit | Control Function | Description                    | Type | Power Up Condition | 0         | 1          |
|-----|------------------|--------------------------------|------|--------------------|-----------|------------|
| 7   | Reserved         | 0                              | R    | 0                  |           |            |
| 6   | OE_6#_RB         | Realtime Readback of OE_6# pin | R    | Realtime           | OE_6# Low | OE_6# High |
| 5   | OE_5#_RB         | Realtime Readback of OE_5# pin | R    | Realtime           | OE_5# Low | OE_5# High |
| 4   | OE_4#_RB         | Realtime Readback of OE_4# pin | R    | Realtime           | OE_4# Low | OE_4# High |
| 3   | OE_3#_RB         | Realtime Readback of OE_3# pin | R    | Realtime           | OE_3# Low | OE_3# High |
| 2   | OE_2#_RB         | Realtime Readback of OE_2# pin | R    | Realtime           | OE_2# Low | OE_2# High |
| 1   | OE_1#_RB         | Realtime Readback of OE_1# pin | R    | Realtime           | OE_1# Low | OE_1# High |
| 0   | OE_0#_RB         | Realtime Readback of OE_0# pin | R    | Realtime           | OE_0# Low | OE_0# High |

### Byte 8: Vendor/Revision Identification Control Register

| Bit | Control Function    | Description             | Type | Power Up Condition | 0 | 1 |
|-----|---------------------|-------------------------|------|--------------------|---|---|
| 7   | Revision Code Bit 3 | Die Revision            | R    | 0                  |   |   |
| 6   | Revision Code Bit 2 |                         | R    | 0                  |   |   |
| 5   | Revision Code Bit 1 |                         | R    | 0                  |   |   |
| 4   | Revision Code Bit 0 |                         | R    | 0                  |   |   |
| 3   | Vendor ID Bit 3     | Diodes/Pericom ID: 0011 | R    | 0                  |   |   |
| 2   | Vendor ID Bit 2     |                         | R    | 0                  |   |   |
| 1   | Vendor ID Bit 1     |                         | R    | 1                  |   |   |
| 0   | Vendor ID Bit 0     |                         | R    | 1                  |   |   |

### Byte 9: Device ID Control Register

| Bit | Control Function | Description | Type | Power-up Condition | 0                                                     | 1 |
|-----|------------------|-------------|------|--------------------|-------------------------------------------------------|---|
| 7   | DTYPE1           | Device type | R    | 0                  | '00' = CG, '01' = ZDB,<br>'10' = Reserve, '11' = NZDB |   |
| 6   | DTYPE0           |             | R    | 0                  |                                                       |   |
| 5   | DID5             | Device ID   | R    | 0                  | 000111 binary, 07Hex                                  |   |
| 4   | DID4             |             | R    | 0                  |                                                       |   |
| 3   | DID3             |             | R    | 0                  |                                                       |   |
| 2   | DID2             |             | R    | 1                  |                                                       |   |
| 1   | DID1             |             | R    | 1                  |                                                       |   |
| 0   | DID0             |             | R    | 1                  |                                                       |   |

### Byte 10: Byte Count Register

| Bit | Control Function | Description                                                            | Type | Power Up Condition | 0 | 1 |
|-----|------------------|------------------------------------------------------------------------|------|--------------------|---|---|
| 7   | Reserved         |                                                                        |      | 0                  |   |   |
| 6   | Reserved         |                                                                        |      | 0                  |   |   |
| 5   | BC5              | Writing to these registers configures how many bytes will be read back | RW   | 0                  |   |   |
| 4   | BC4              |                                                                        | RW   | 0                  |   |   |
| 3   | BC3              |                                                                        | RW   | 1                  |   |   |
| 2   | BC2              |                                                                        | RW   | 0                  |   |   |
| 1   | BC1              |                                                                        | RW   | 0                  |   |   |
| 0   | BC0              |                                                                        | RW   | 0                  |   |   |

### Byte 11: Side-Band Interface Mask Register 0

| Bit | Control Function | Description        | Type | Power Up Condition | 0   | 1  |
|-----|------------------|--------------------|------|--------------------|-----|----|
| 7   | Mask_MXCK8       | SBI Mask for MXCK8 | RW   | 0                  | Off | On |
| 6   | Mask_100M6       | SBI Mask for 100M6 | RW   | 0                  | Off | On |
| 5   | Mask_100M5       | SBI Mask for 100M5 | RW   | 0                  | Off | On |
| 4   | Mask_100M4       | SBI Mask for 100M4 | RW   | 0                  | Off | On |
| 3   | Mask_100M3       | SBI Mask for 100M3 | RW   | 0                  | Off | On |
| 2   | Mask_100M2       | SBI Mask for 100M2 | RW   | 0                  | Off | On |
| 1   | Mask_100M1       | SBI Mask for 100M1 | RW   | 0                  | Off | On |
| 0   | Mask_100M0       | SBI Mask for 100M0 | RW   | 0                  | Off | On |

**Note:** If '0', the Side-Band Interface register may disable the output. If '1', the Side-Band Interface cannot disable the output. Such an output may only be disabled by the respective SMBus bit, or OE# pin (present only for 100M outputs).

### Byte 12: Side-Band Interface Mask Register 1

| Bit | Control Function | Description        | Type | Power Up Condition | 0   | 1  |
|-----|------------------|--------------------|------|--------------------|-----|----|
| 7   | Mask_MXCK7       | SBI Mask for MXCK7 | RW   | 0                  | Off | On |
| 6   | Mask_MXCK6       | SBI Mask for MXCK6 | RW   | 0                  | Off | On |
| 5   | Mask_MXCK5       | SBI Mask for MXCK5 | RW   | 0                  | Off | On |
| 4   | Mask_MXCK4       | SBI Mask for MXCK4 | RW   | 0                  | Off | On |
| 3   | Mask_MXCK3       | SBI Mask for MXCK3 | RW   | 0                  | Off | On |
| 2   | Mask_MXCK2       | SBI Mask for MXCK2 | RW   | 0                  | Off | On |
| 1   | Mask_MXCK1       | SBI Mask for MXCK1 | RW   | 0                  | Off | On |
| 0   | Mask_MXCK0       | SBI Mask for MXCK0 | RW   | 0                  | Off | On |

**Note:** If '0', the Side-Band Interface register may disable the output. If '1', the Side-Band Interface cannot disable the output. Such an output may only be disabled by the respective SMBus bit.

### Byte 13: Side-Band Interface Mask Register 2

| Bit | Control Function | Description          | Type | Power Up Condition | 0   | 1  |
|-----|------------------|----------------------|------|--------------------|-----|----|
| 7   | Reserved         |                      |      | 0                  |     |    |
| 6   | Reserved         |                      |      | 0                  |     |    |
| 5   | Reserved         |                      |      | 0                  |     |    |
| 4   | Reserved         |                      |      | 0                  |     |    |
| 3   | Mask_PFT_OUT     | SBI Mask for PFT_OUT | RW   | 0                  | Off | On |
| 2   | Mask_25M2        | SBI Mask for 25M2    | RW   | 0                  | Off | On |
| 1   | Mask_25M1        | SBI Mask for 25M1    | RW   | 0                  | Off | On |
| 0   | Mask_25M0        | SBI Mask for 25M0    | RW   | 0                  | Off | On |

**Note:** If '0', the Side-Band Interface register may disable the output. If '1', the Side-Band Interface cannot disable the output. Such an output may only be disabled by the respective SMBus bit.

### Byte 14: Side-Band Interface Readback Register 0

| Bit | Control Function | Description        | Type | Power Up Condition | 0        | 1       |
|-----|------------------|--------------------|------|--------------------|----------|---------|
| 7   | MXCK8_RB         | SBI Readback MXCK8 | R    | 1                  | Disabled | Enabled |
| 6   | 100M6_RB         | SBI Readback 100M6 | R    | 1                  | Disabled | Enabled |
| 5   | 100M5_RB         | SBI Readback 100M5 | R    | 1                  | Disabled | Enabled |
| 4   | 100M4_RB         | SBI Readback 100M4 | R    | 1                  | Disabled | Enabled |
| 3   | 100M3_RB         | SBI Readback 100M3 | R    | 1                  | Disabled | Enabled |
| 2   | 100M2_RB         | SBI Readback 100M2 | R    | 1                  | Disabled | Enabled |
| 1   | 100M1_RB         | SBI Readback 100M1 | R    | 1                  | Disabled | Enabled |
| 0   | 100M0_RB         | SBI Readback 100M0 | R    | 1                  | Disabled | Enabled |

**Note:** If the Side-Band interface is used, this register latches the content of the shift register. A '0' indicates that the corresponding differential output is disabled unless the bit has been masked off in SBI Mask register. A '1' indicates that the output is enabled if the corresponding SMBus OE bit is set high and OE# pin (present only for 100M outputs) is pulled low.

### Byte 15: Side-Band Interface Readback Register 1

| Bit | Control Function | Description        | Type | Power Up Condition | 0        | 1       |
|-----|------------------|--------------------|------|--------------------|----------|---------|
| 7   | MXCK7_RB         | SBI Readback MXCK7 | R    | 1                  | Disabled | Enabled |
| 6   | MXCK6_RB         | SBI Readback MXCK6 | R    | 1                  | Disabled | Enabled |
| 5   | MXCK5_RB         | SBI Readback MXCK5 | R    | 1                  | Disabled | Enabled |
| 4   | MXCK4_RB         | SBI Readback MXCK4 | R    | 1                  | Disabled | Enabled |
| 3   | MXCK3_RB         | SBI Readback MXCK3 | R    | 1                  | Disabled | Enabled |
| 2   | MXCK2_RB         | SBI Readback MXCK2 | R    | 1                  | Disabled | Enabled |
| 1   | MXCK1_RB         | SBI Readback MXCK1 | R    | 1                  | Disabled | Enabled |
| 0   | MXCK0_RB         | SBI Readback MXCK0 | R    | 1                  | Disabled | Enabled |

**Note:** If '0', the Side-Band Interface register may disable the output. If '1', the Side-Band Interface cannot disable the output. Such an output may only be disabled by the respective SMBus bit

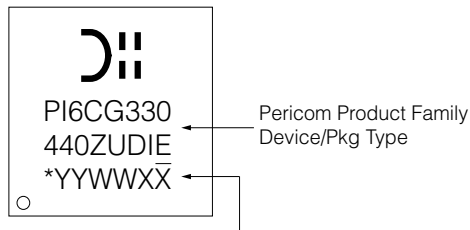
### Byte 16: Side-Band Interface Readback Register 2

| Bit | Control Function | Description          | Type | Power Up Condition | 0        | 1       |
|-----|------------------|----------------------|------|--------------------|----------|---------|
| 7   | Reserved         |                      |      | 0                  |          |         |
| 6   | Reserved         |                      |      | 0                  |          |         |
| 5   | Reserved         |                      |      | 0                  |          |         |
| 4   | Reserved         |                      |      | 0                  |          |         |
| 3   | PFT_OUT_RB       | SBI Readback PFT_OUT | R    | 1                  | Disabled | Enabled |
| 2   | 25M2_RB          | SBI Readback 25M2    | R    | 1                  | Disabled | Enabled |
| 1   | 25M1_RB          | SBI Readback 25M1    | R    | 1                  | Disabled | Enabled |
| 0   | 25M0_RB          | SBI Readback 25M0    | R    | 1                  | Disabled | Enabled |

**Note:** If the Side-Band interface is used, this register latches the content of the shift register. A '0' indicates that the corresponding differential output is disabled unless the bit has been masked off in SBI Mask register. A '1' indicates that the output is enabled if the corresponding SMBus OE bit is set high and OE# pin (present only for 100M outputs) is pulled low.

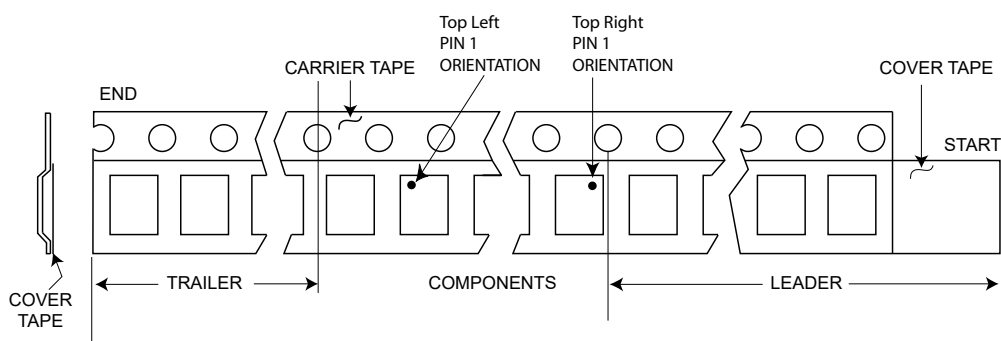
**PI6CG330440**

## Part Marking



\*: Die Rev  
YY: Year  
WW: Workweek  
1st X: Assembly Code  
2nd X: Fab Code  
Note: Date Code per MA-1251

## Package Information

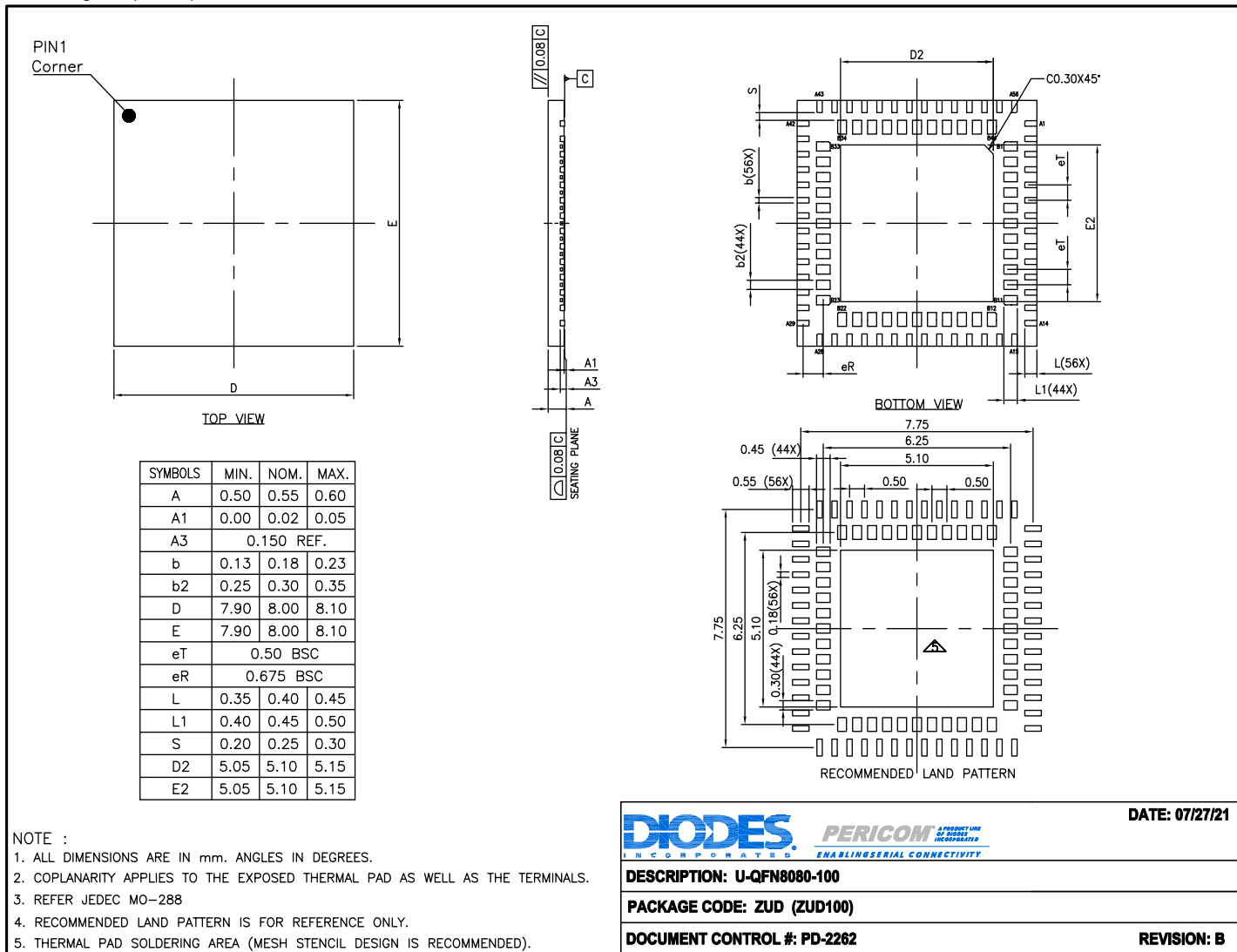




**PI6CG330440**

## Packaging Mechanical

### 100-UQFN (ZUD)



#### NOTE :

1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED THERMAL PAD AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-288
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA (MESH STENCIL DESIGN IS RECOMMENDED).

For latest package info.

21-1412

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

## Ordering Information

| Ordering Code         | Package Code | Package Description                              | Pin 1 Orientation |
|-----------------------|--------------|--------------------------------------------------|-------------------|
| PI6CG330440ZUDIEX     | ZUD          | 100-Contact, Ultra Thin Quad Flat No-Lead (UQFN) | Top Right Corner  |
| PI6CG330440ZUDIEX-13R | ZUD          | 100-Contact, Ultra Thin Quad Flat No-Lead (UQFN) | Top Left Corner   |

#### Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. I = Industrial
5. E = Pb-free and Green
6. X suffix = Tape/Reel
7. For packaging detail, go to our website at: <https://www.diodes.com/assets/MediaList-Attachments/Diodes-Package-Information.pdf>

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